

Preparation and operation of SiW-ECAL technological prototype for DESY test beam 2019



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九州大学
KYUSHU UNIVERSITY



東京大学
THE UNIVERSITY OF TOKYO

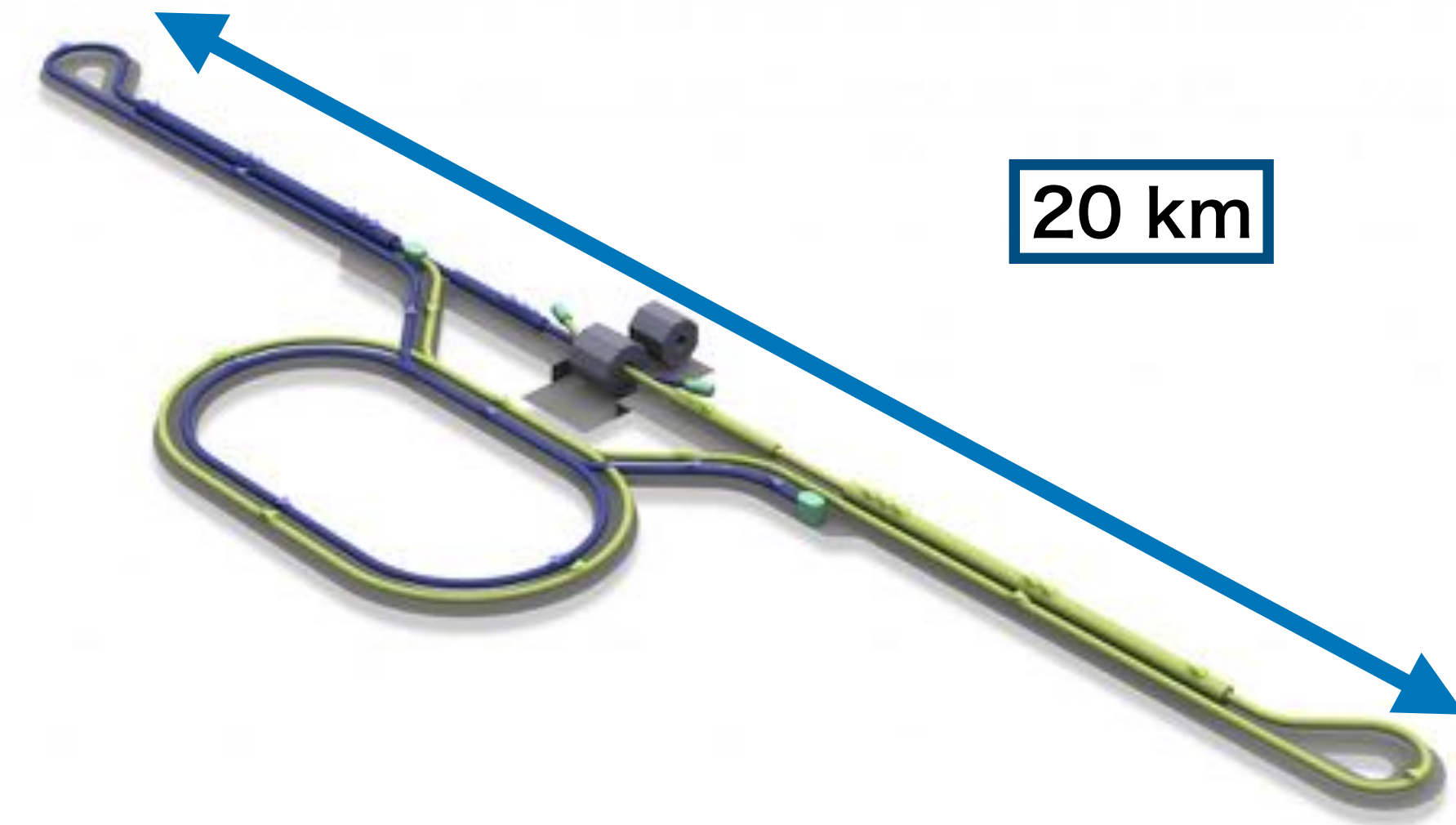
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Vincent Boudry^C, Roman Poeschl^D, Adrian Irles^D, and ILD SiW-ECAL group.

(A: Kyushu University, B: The University of Tokyo, C: LLR, D: LAL)



ILC (International Linear Collider)

- Collision of the electron and positron
- Center of mass energy : 250 GeV
- exploring new physics by precise measurement of the SM particle, especially higgs



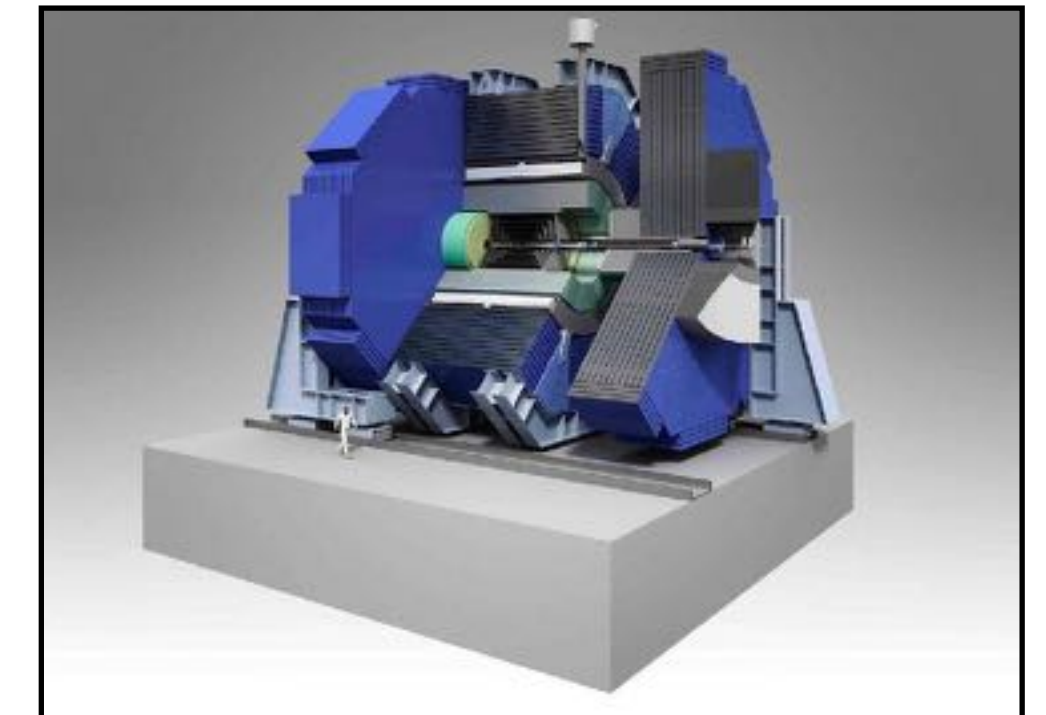
- Two candidates of the detector

- **ILD (International Large Detector)**
- SiD (Silicon Detector)

ILD



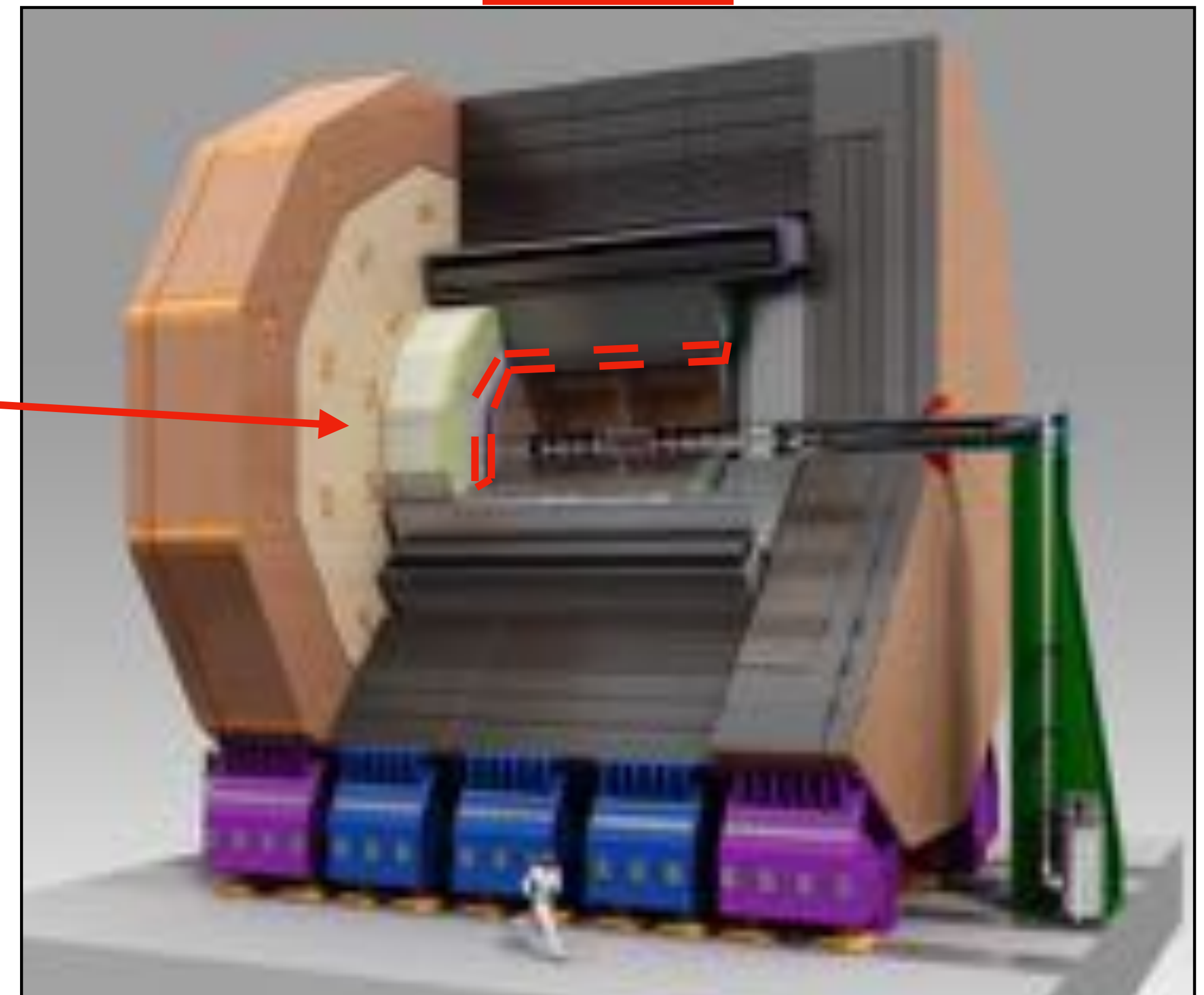
SiD



ILD (International Large Detector)

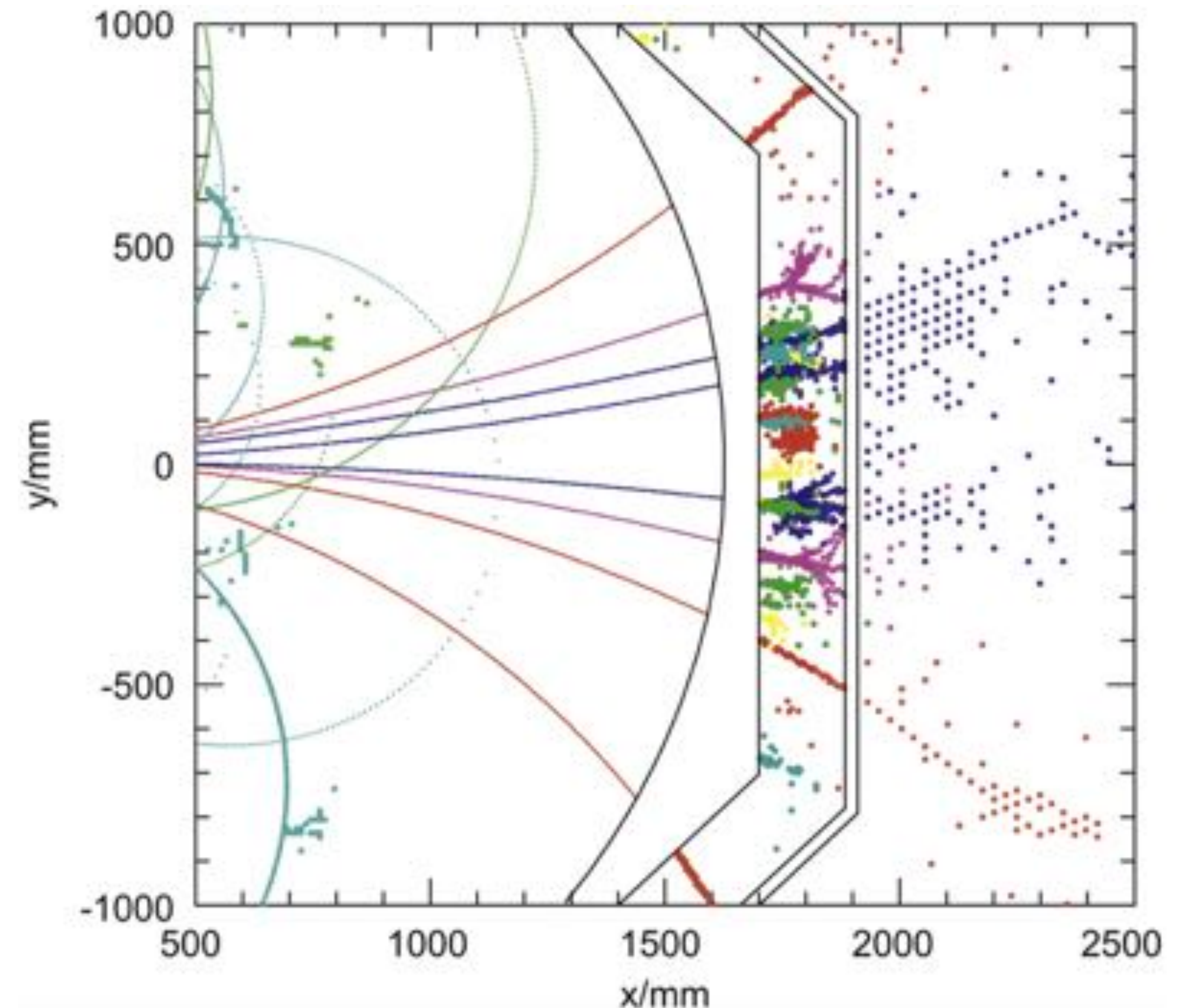
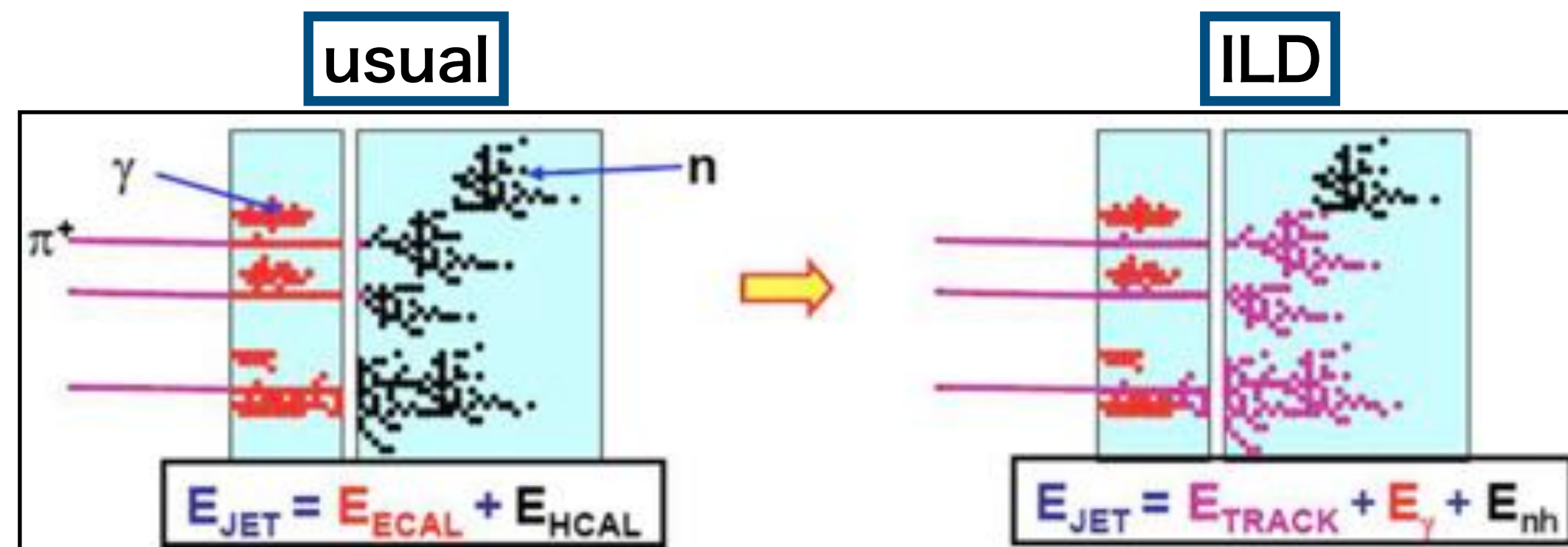
- ILD components
 - Vertex detector
 - Tracking detector
 - Electromagnetic calorimeter
 - ScW-ECAL : using scintillator
 - **SiW-ECAL : using Si semiconductor**
 - Hadron calorimeter
 - Muon detector

ILD ECAL



PFA (Particle Flow Algorithm)

- Separation of the particles in jets
- Reconstruction with appropriate detector
 - charged particle : Tracking detector
 - photon : Electromagnetic calorimeter
 - neutral particle : Hadron calorimeter

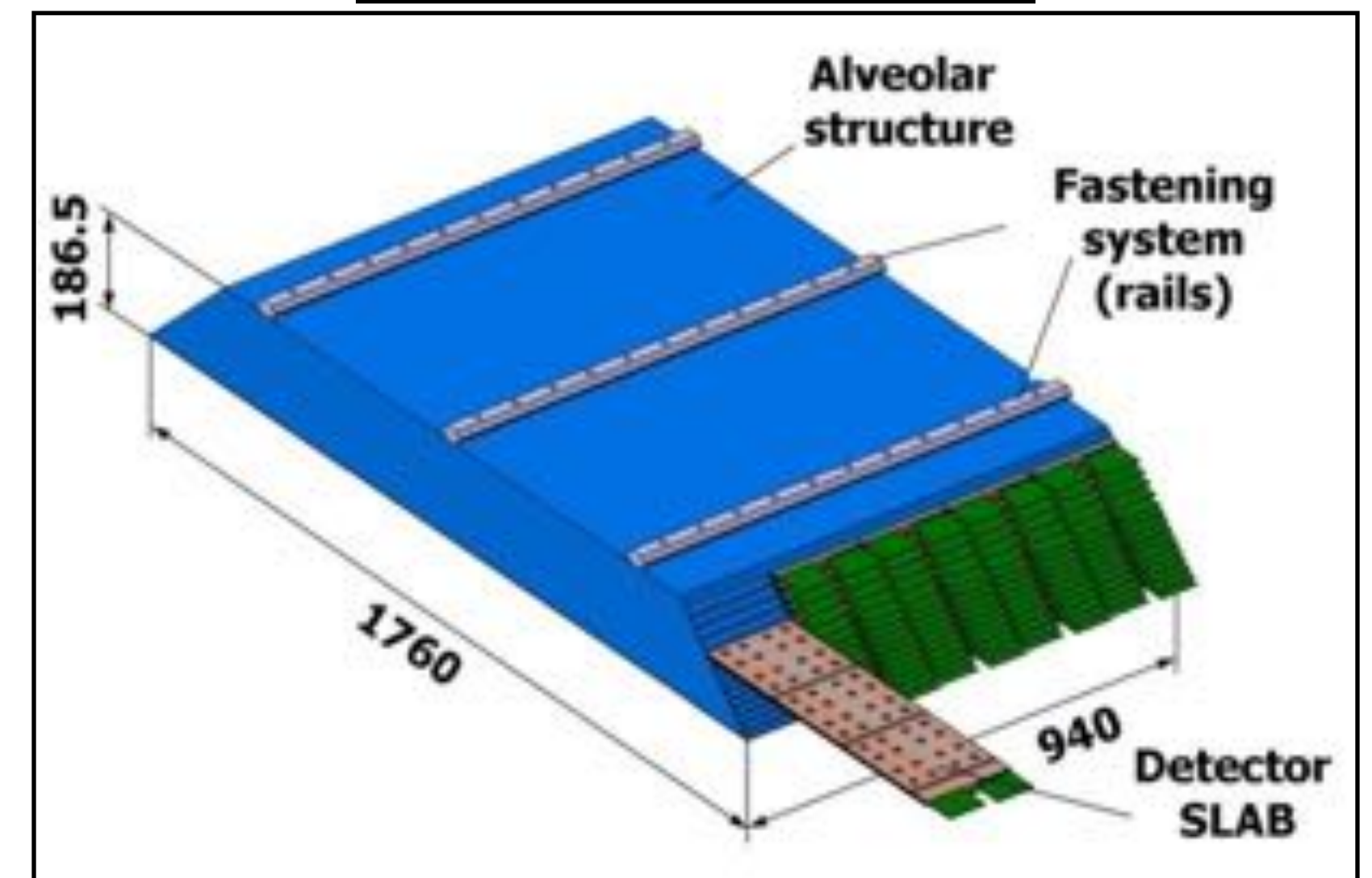


SiW-ECAL

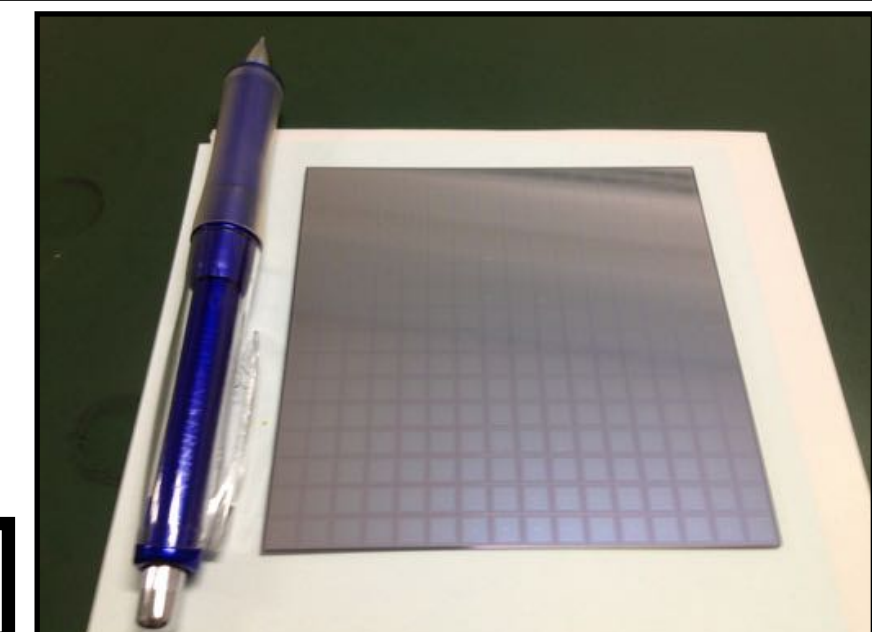
- The electromagnetic calorimeter in ILD is a sampling calorimeter with 20-30 layers

ILD ECAL in Barrel

- SiW-ECAL
 - Tungsten (absorber)
 - Silicon (detector)
 - granularity requirement : 5 mm × 5 mm
 - silicon pad : 90 mm × 90 mm (256 pixels)
 - Si thickness : 320 μm, 650 μm

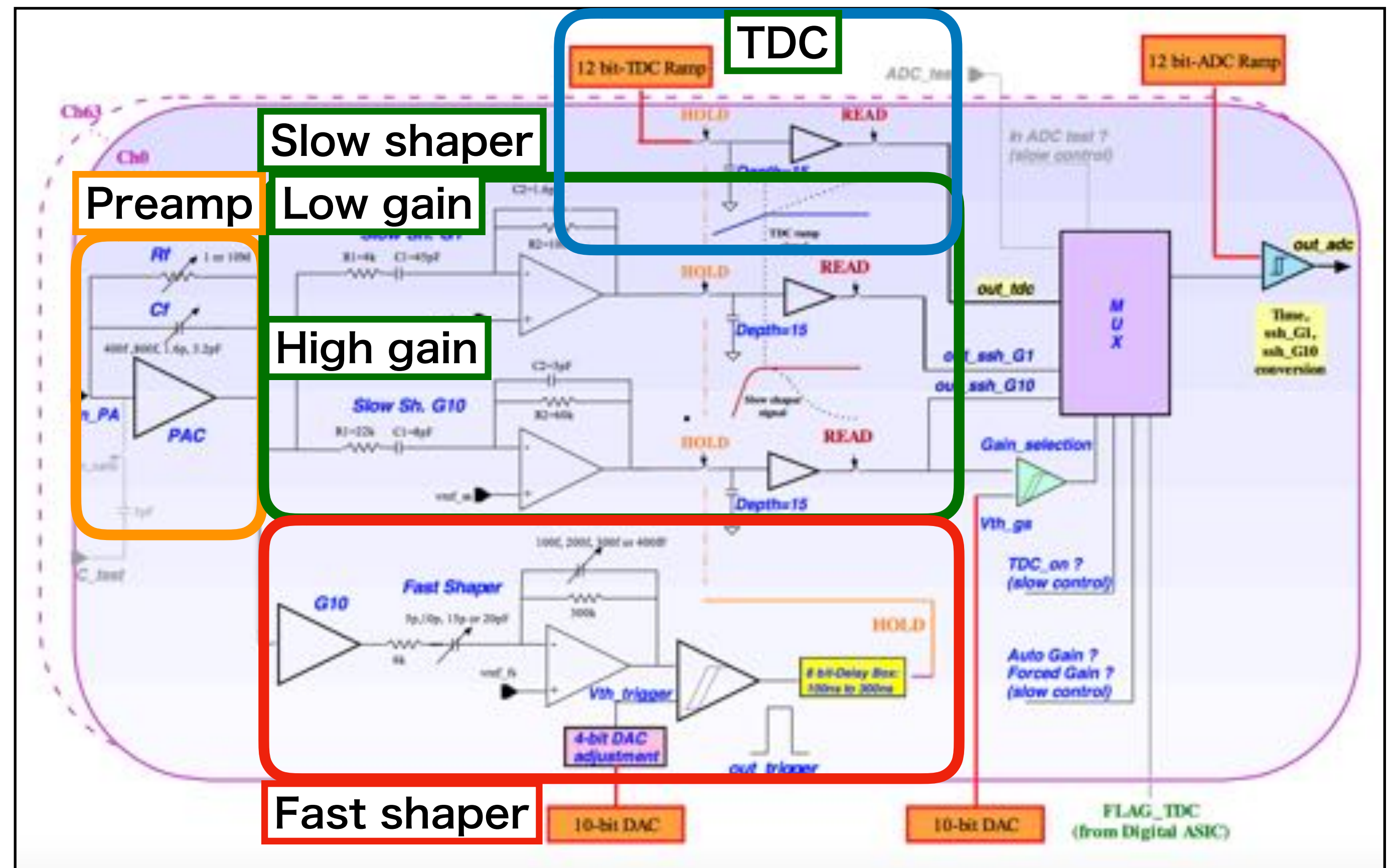


silicon pad



ASIC

- ASICs (SKIROC2/2A) are used as the integrated circuit for data taking
- SKIROC2A
 - 64 channel
 - 15 memory cells
 - ADC mode
 - ADC high and low gain
 - TDC mode
 - TDC
 - ADC high or low gain



R&D of the SiW-ECAL

- The development phase is proceeding the following changes

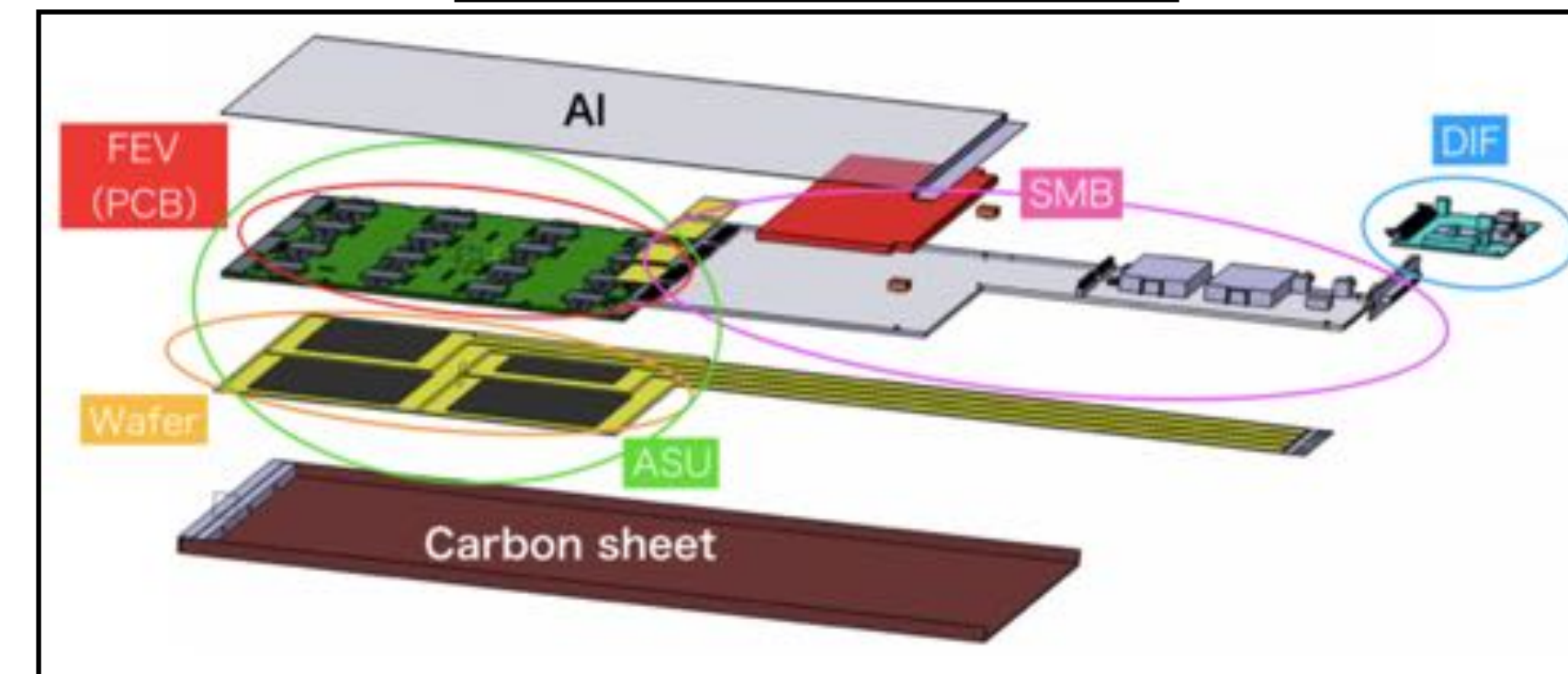
- The physics prototype

- Studying the Si detector satisfying ILD requirement
- Development of the sensor and reading circuit

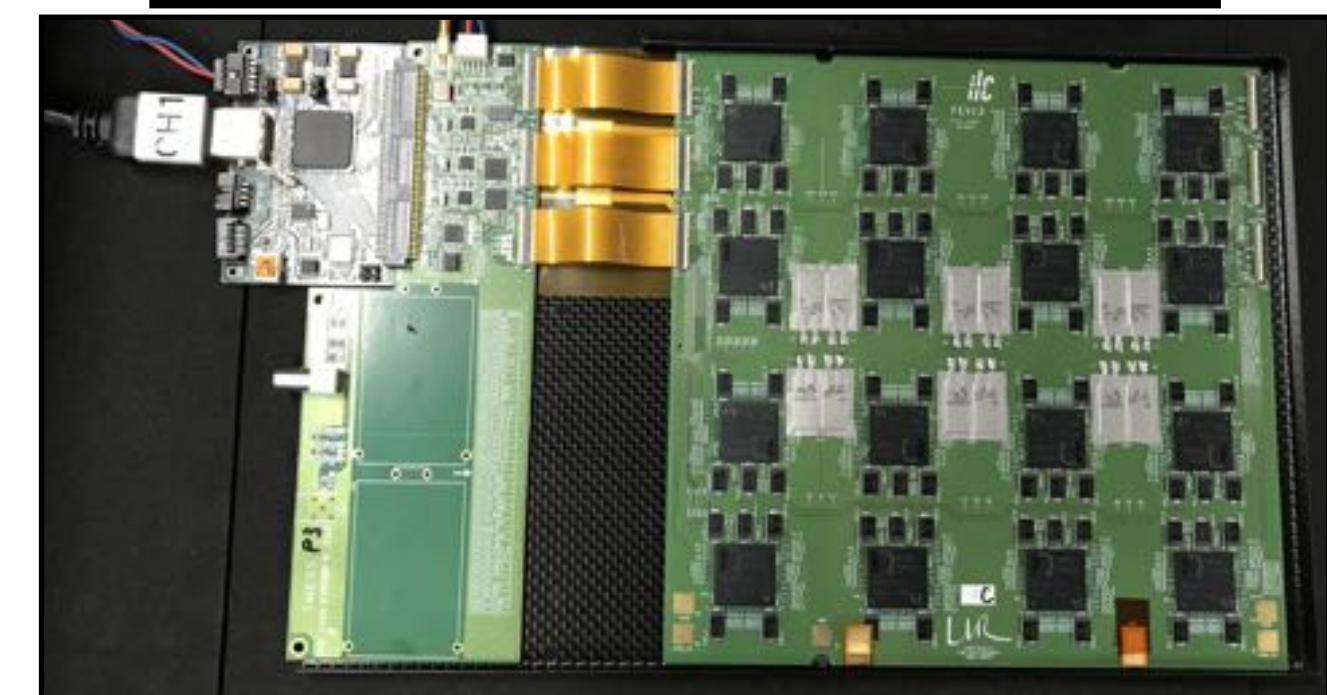
- The technological prototype

- Optimization of the DAQ systems for implementation to ILD
- slab : just one layer of the SiW-ECAL
- One slab has 4 silicon pads (1024 pixels)
 - read by 16 ASICs (1 ASIC : 64 ch)

slab components



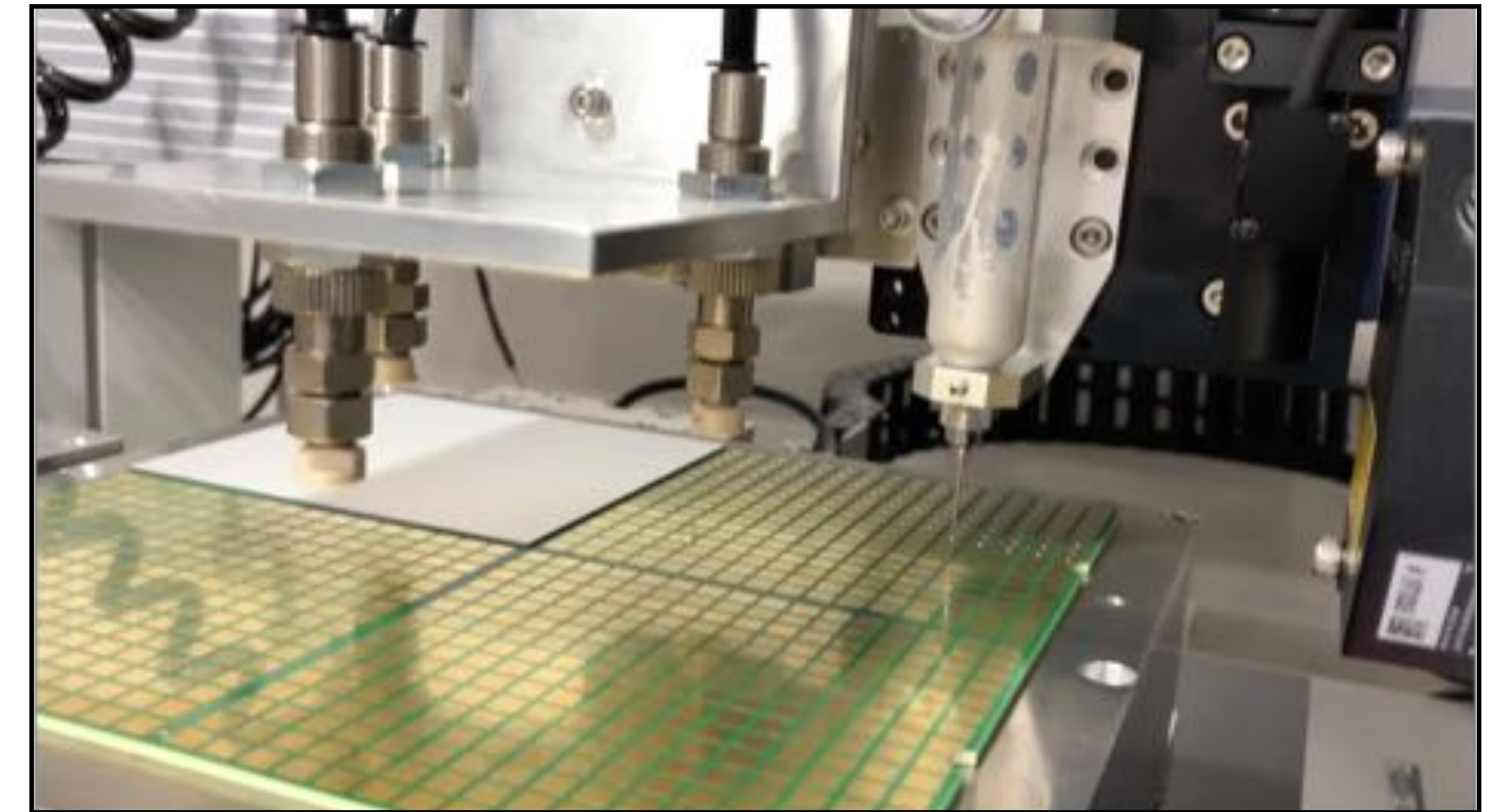
technological prototype



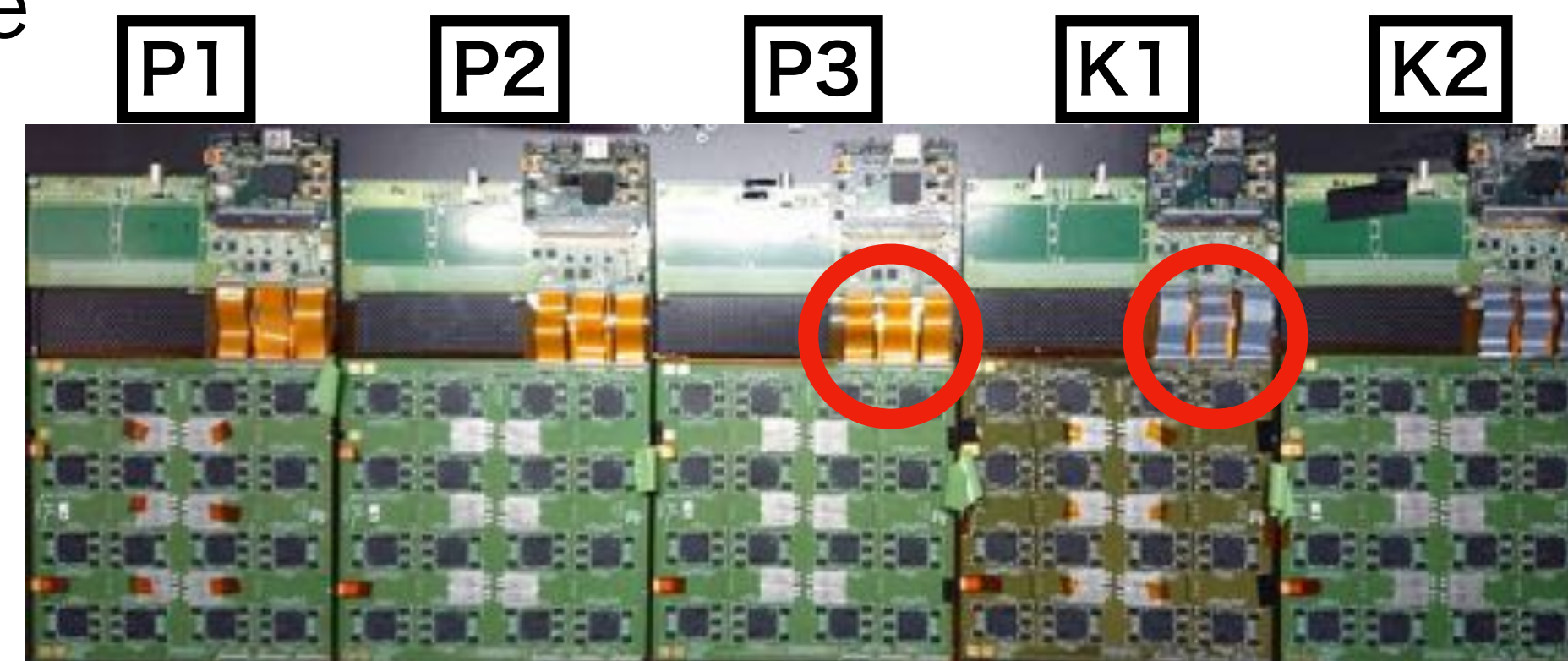
Assembly of the latest model (in Kyushu)

- 5 slabs are assembled in Kyushu University
- Gluing FEV and SMB to FPC
- Si thickness : 320 μm (P3), 650 μm (others)
- The difference between P and K
 - P : Flexible cable
 - K : Micro-coaxial cable

gluing in Kyushu



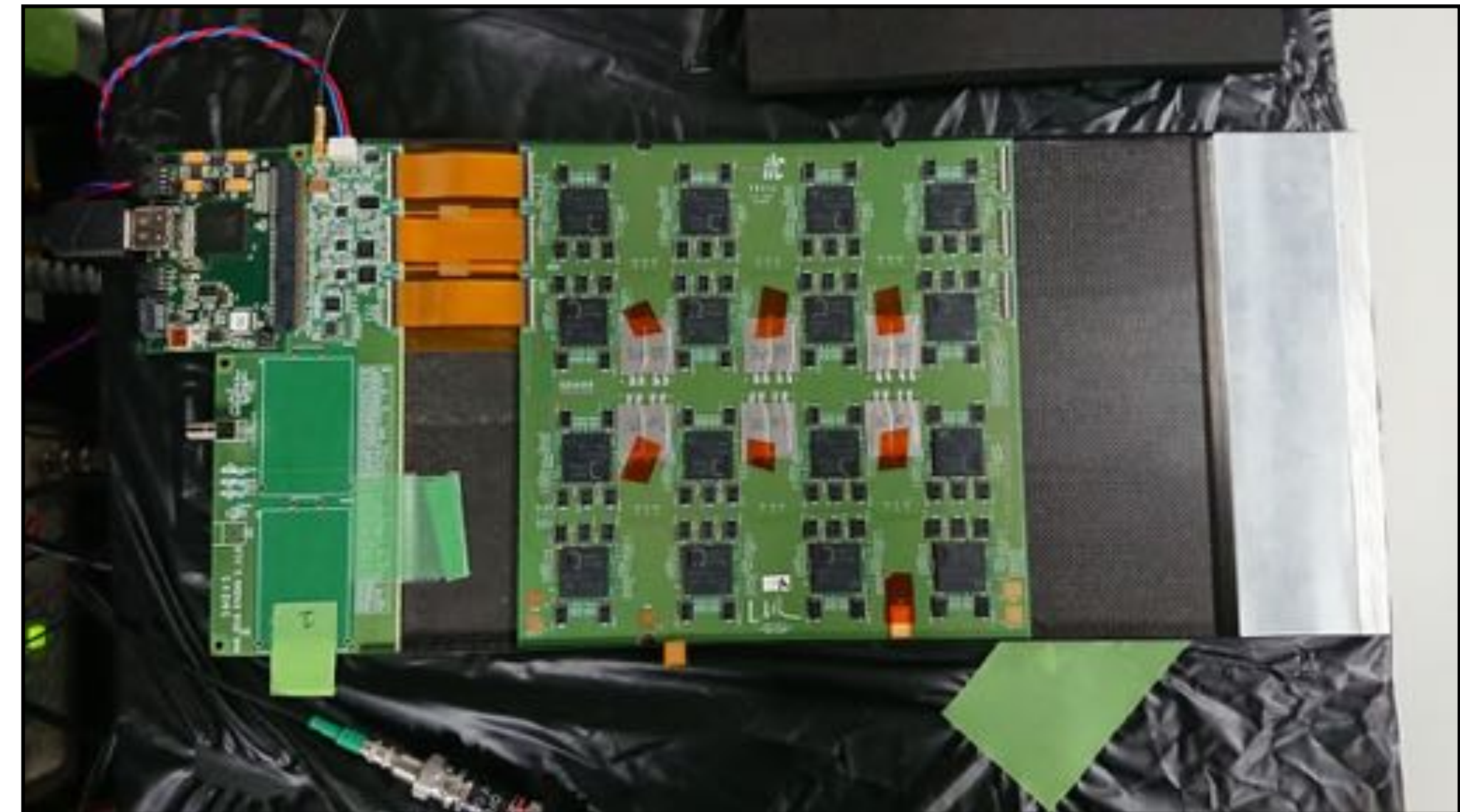
Manually



Previous Test Beam

- 2018 (DESY)
 - evaluation using the just one slab
 - particle : electron
- 2018 (CERN/SPS)
 - evaluation using the 5 slabs
 - particle : muon, electron, pion
 - 4 slabs had the problem in HV → data taking is difficult using the older model's carbon plate

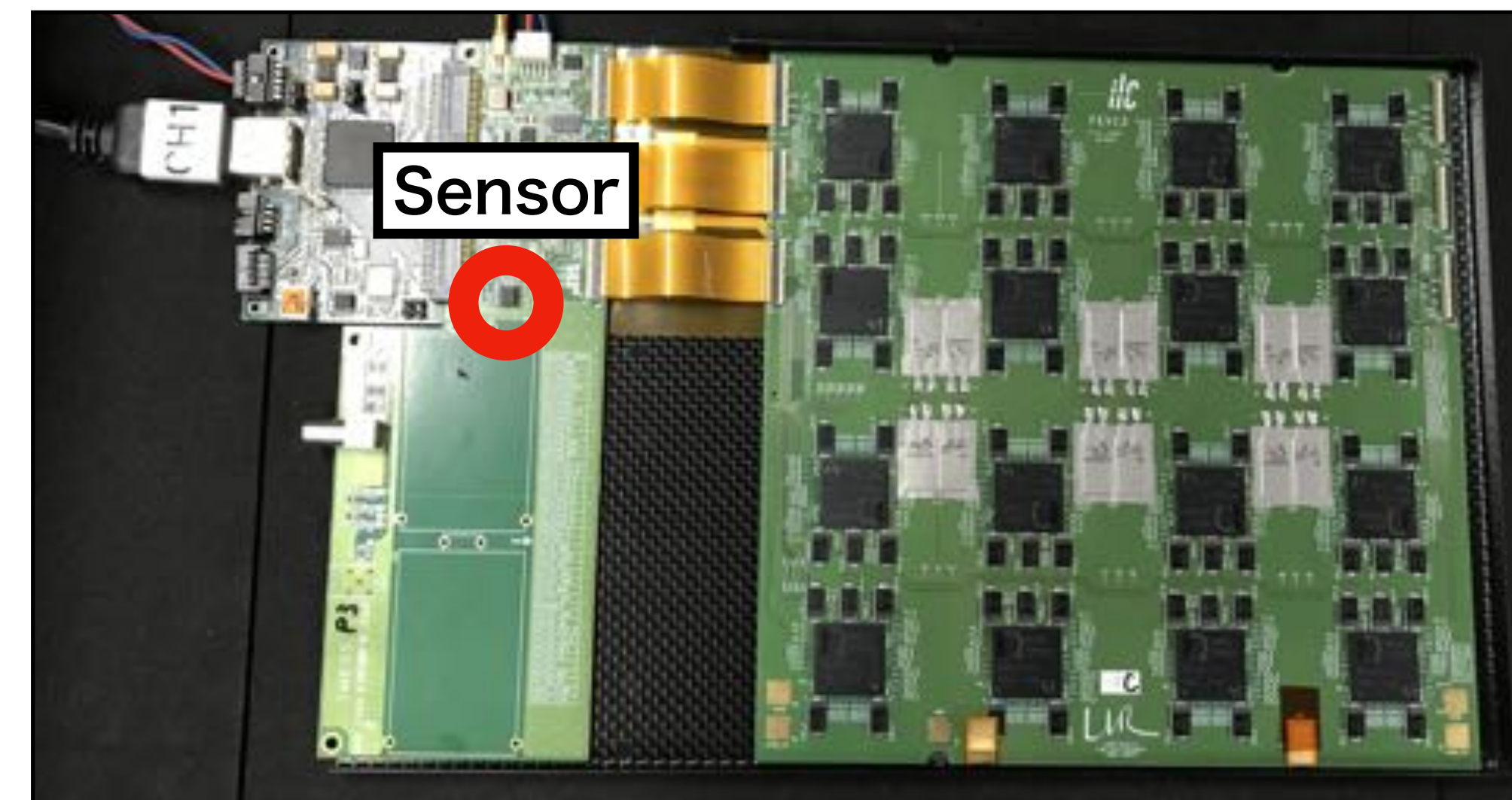
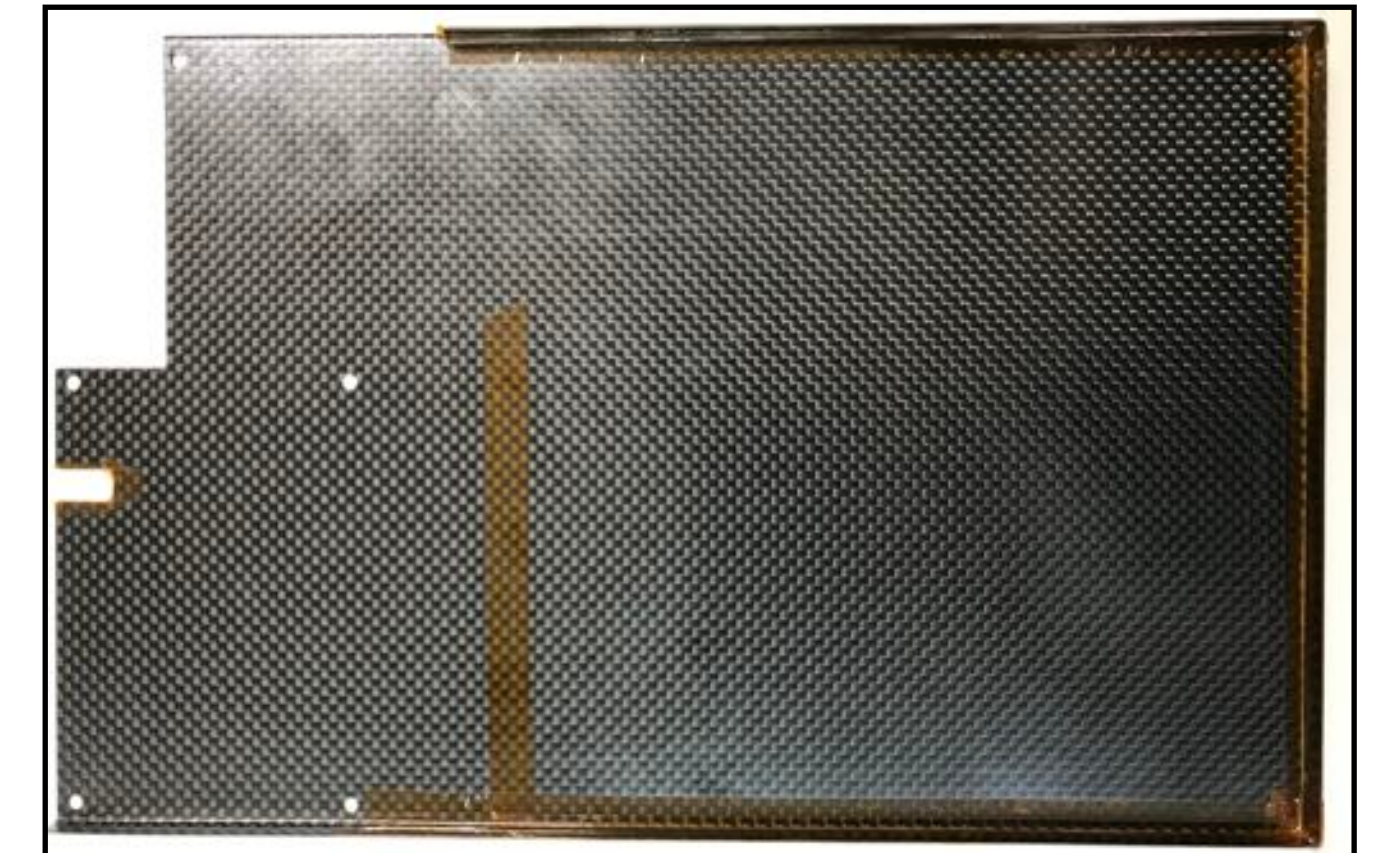
with older carbon plate



Update from previous TB

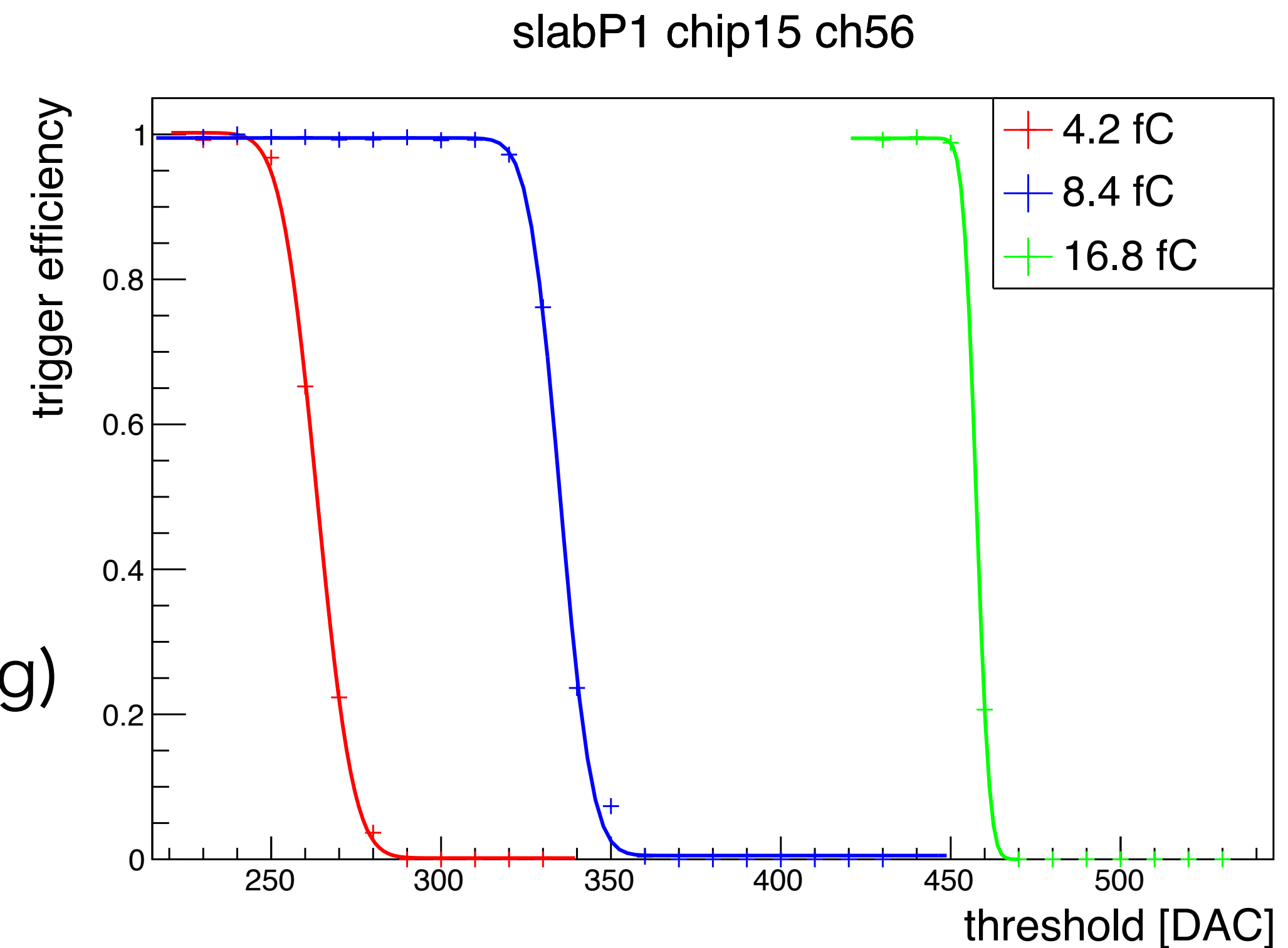
- Replace the carbon plate on the backside and cover
 - New carbon plate :
 - cut the edge of the HV connector side
 - pushing with screw
 - leakage current
- Temperature monitoring
 - It is the first time temperature measuring

New carbon plate



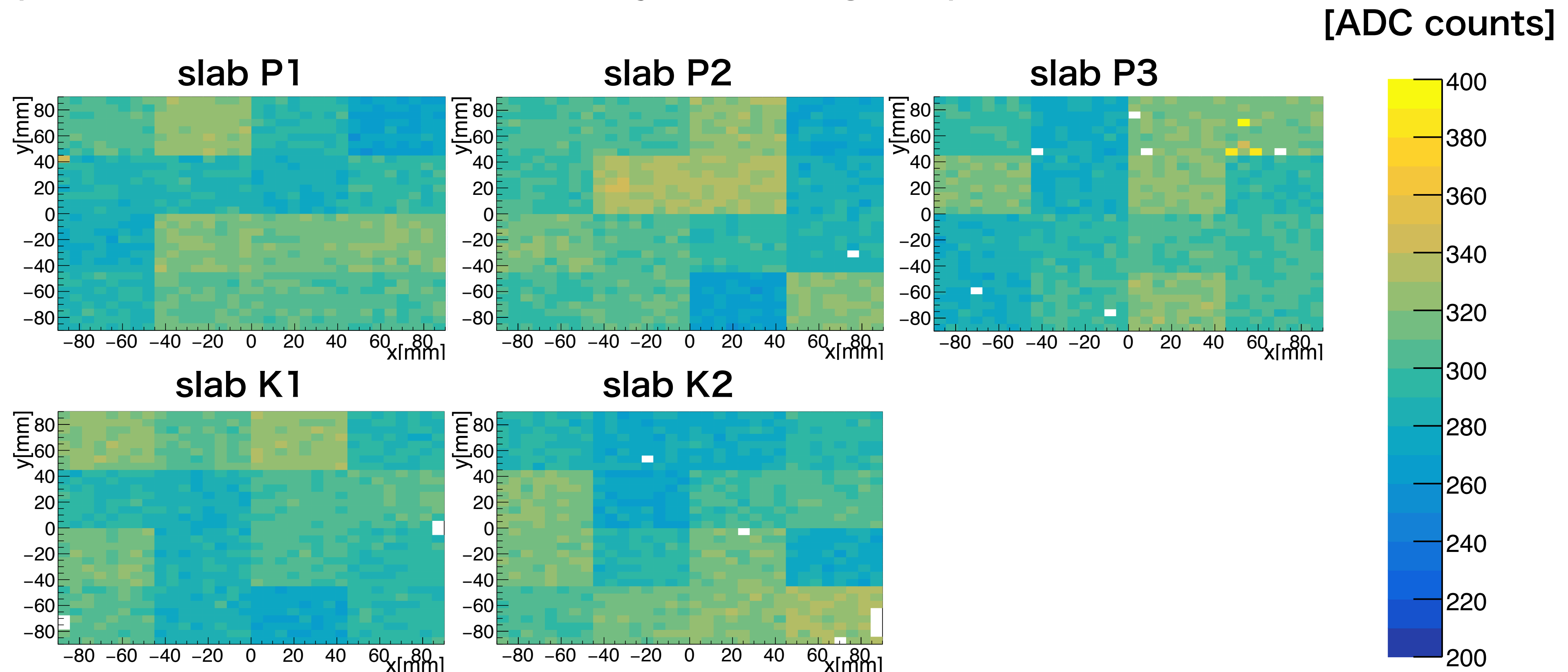
Laboratory Test (1)

- S/N in the trigger line
 - defined by the study of the trigger line (fast shaper in SKIROC)
- threshold scans with charge injections
 - 1.4 mVpp : 1 MIP
 - 2.8 mVpp : 2 MIP
 - 5.6 mVpp : 4 MIP
- We can see the S curve
(As the trigger line is higher, signal is decreasing)



Laboratory Test (2)

- Pedestal means for all channels are measured with thermal noise
- Each pedestal means are shown by following maps



Laboratory Test (3)

- Data acquisition test with radiation sources
- Data were measured using the ^{133}Ba and ^{57}Co as gamma radiation sources

sources



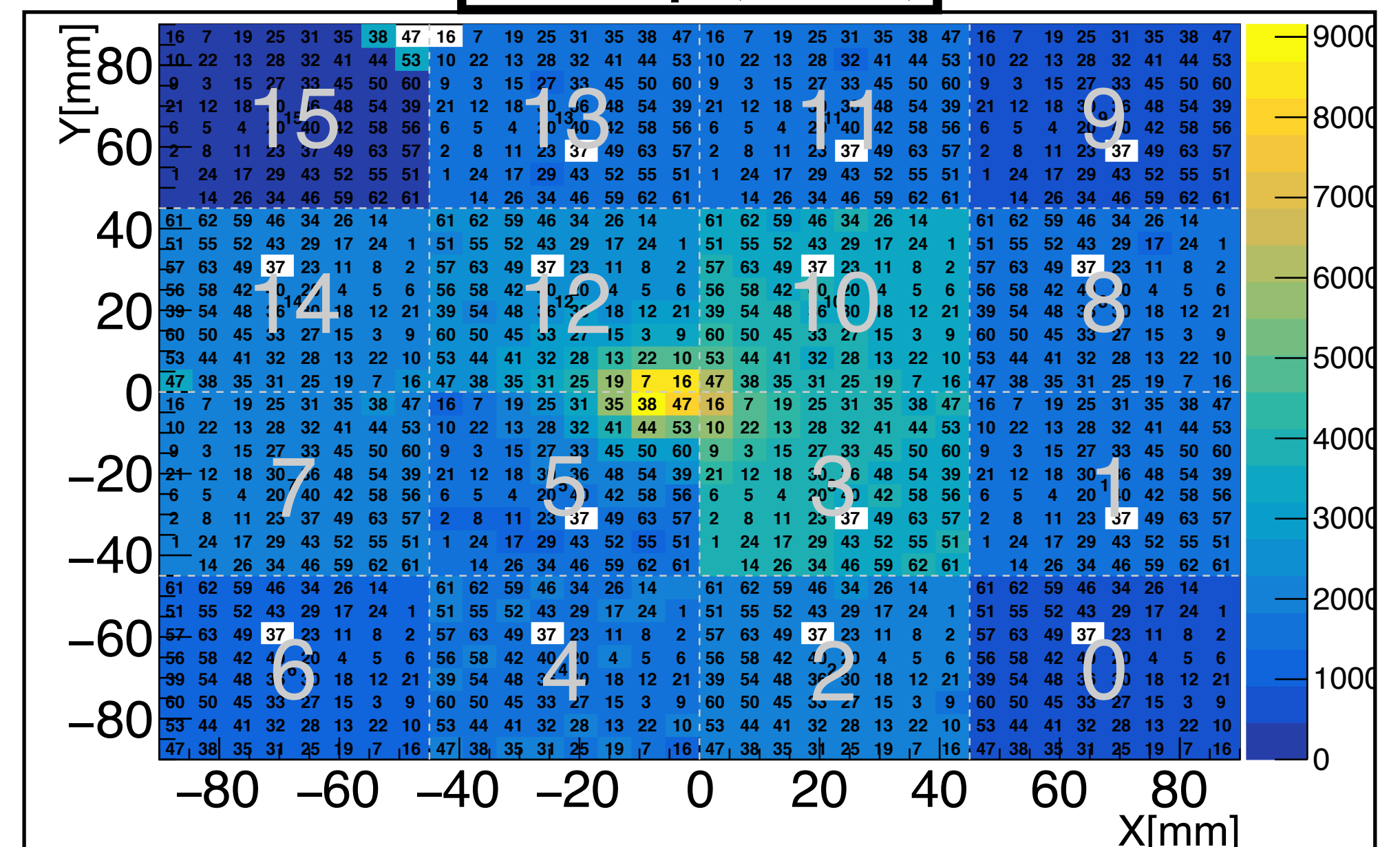
- ^{133}Ba :

- 356 keV (62.1%)
 - $E_e = 207.25$ keV
- 81.0 keV (34.1%)

- ^{57}Co :

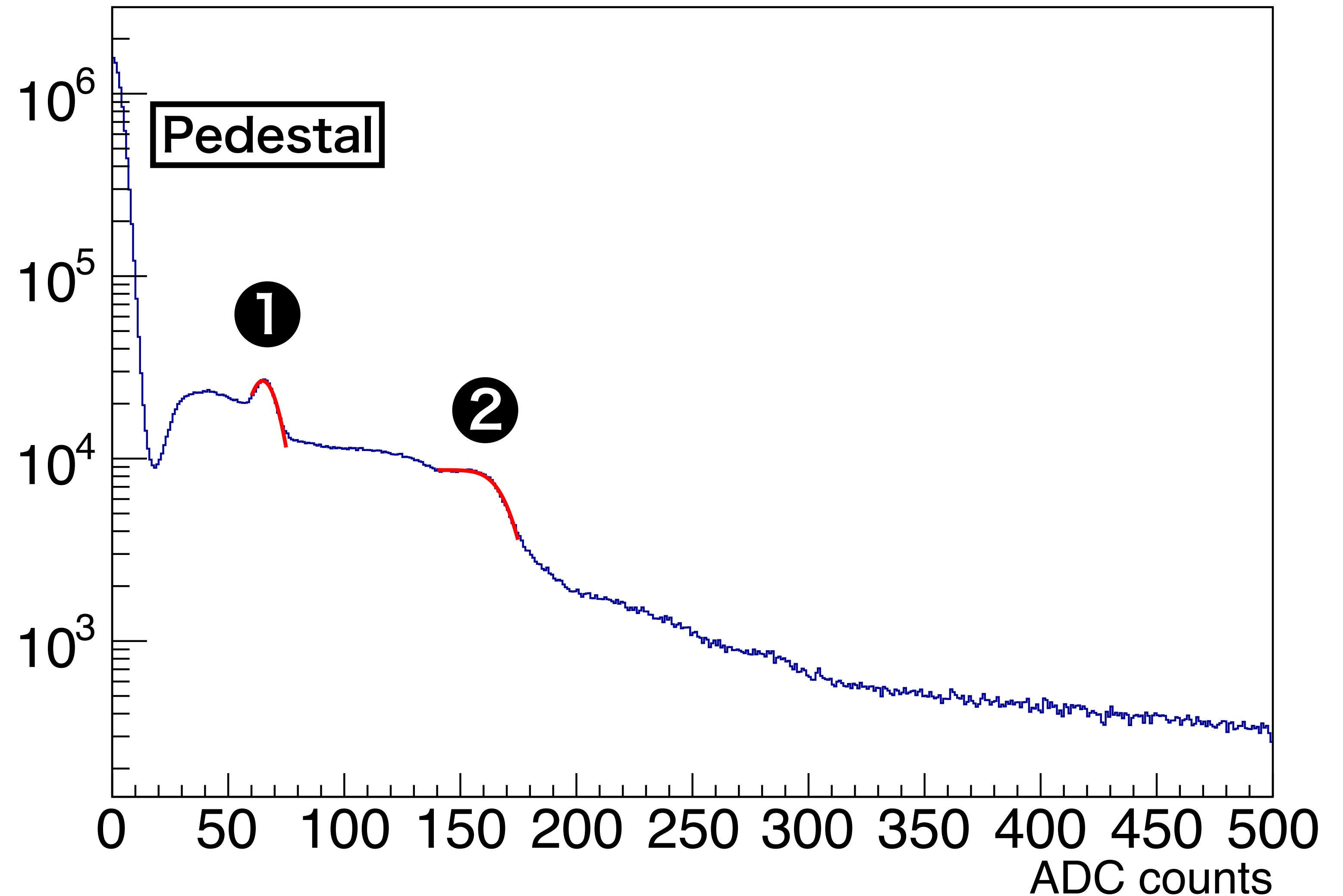
- 122 keV (85.6%)
- 136 keV (10.7%)

Hit map (^{133}Ba)



Laboratory Test (3)

- ^{133}Ba ADC Histogram
- ①
 - Photoelectric peak
 - 81.0 keV
 - 64.8 ch
- ②
 - Compton edge
 - 207.25 keV
 - 173.0 ch



Laboratory Test (3)

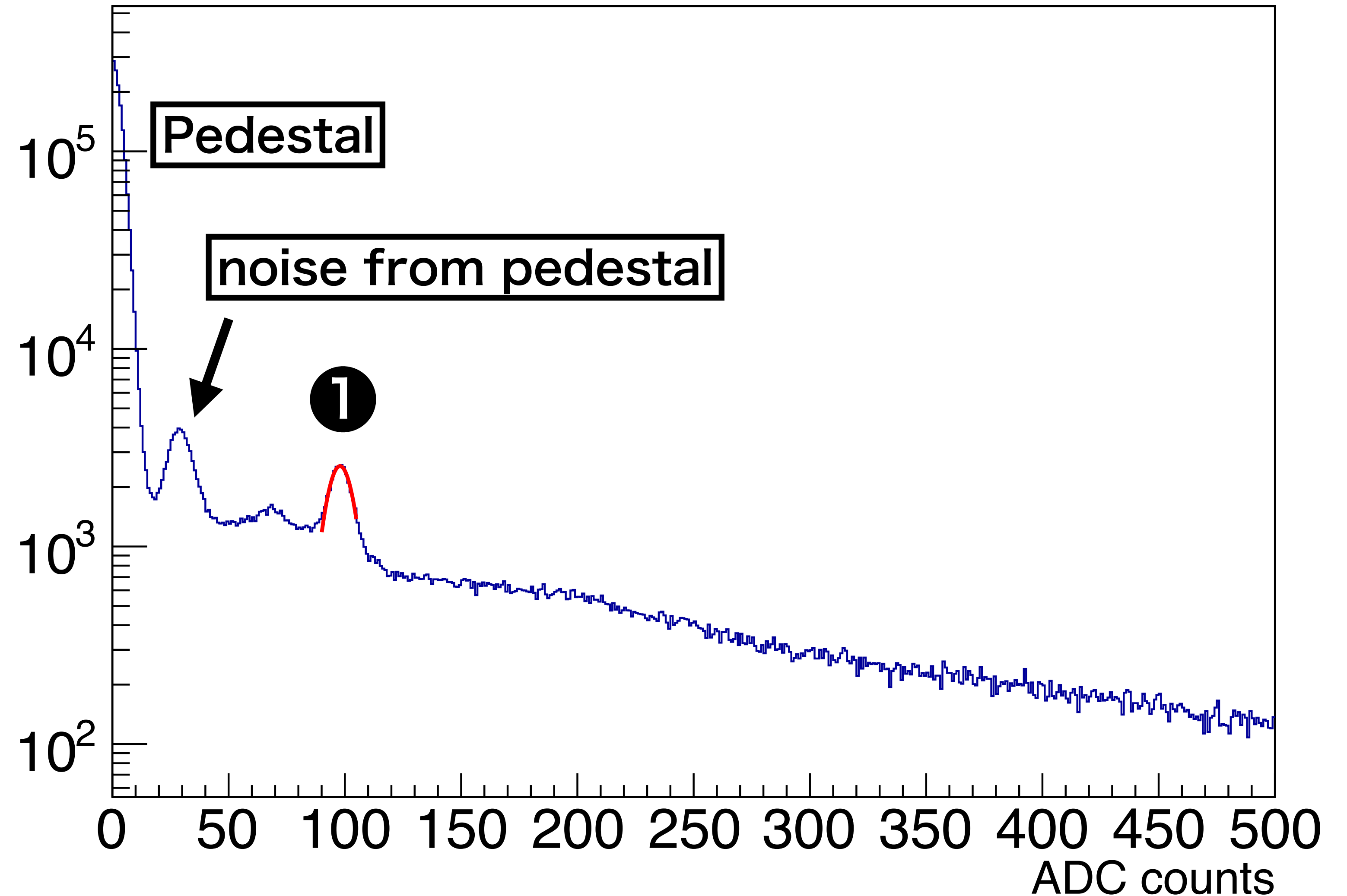
- ^{57}Co ADC Histogram

- ①

- Photoelectric peak

- 122 keV

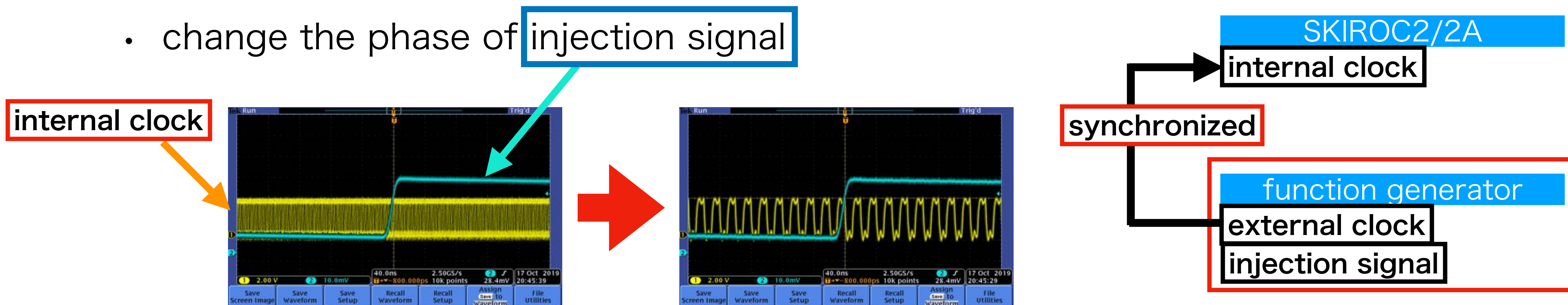
- 97.9 ch



Laboratory Test (4)

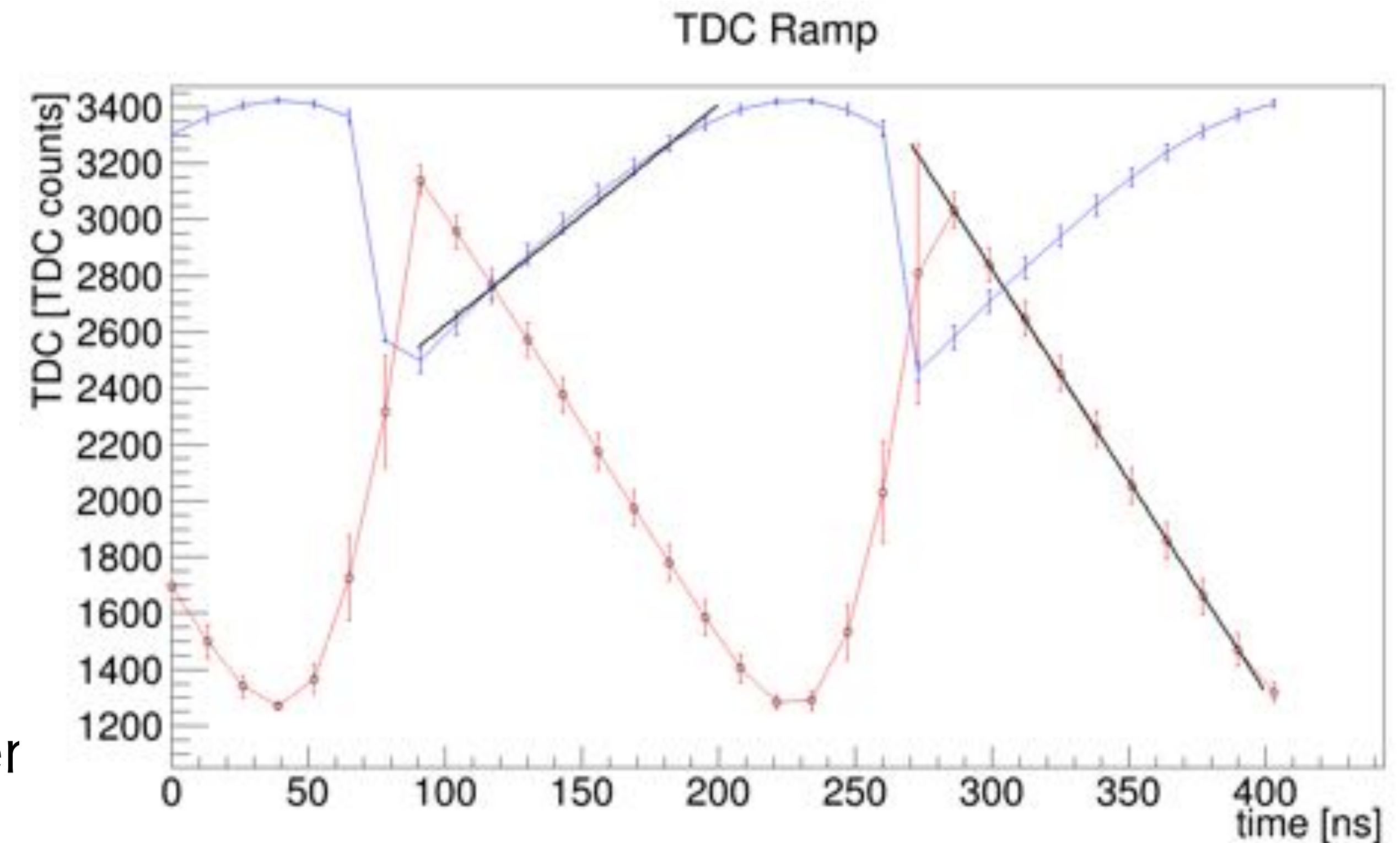
- TDC mode operation test
- SKIROC2/2A has the ramp wave as one of the internal clocks
 - frequency : 2.5 MHz or **5 MHz** (we can choose with rewriting firmware)
- The ramp wave can be measured with
 - synchronization of internal and external clock (injection signal)

- change the phase of **injection signal**



Laboratory Test (4)

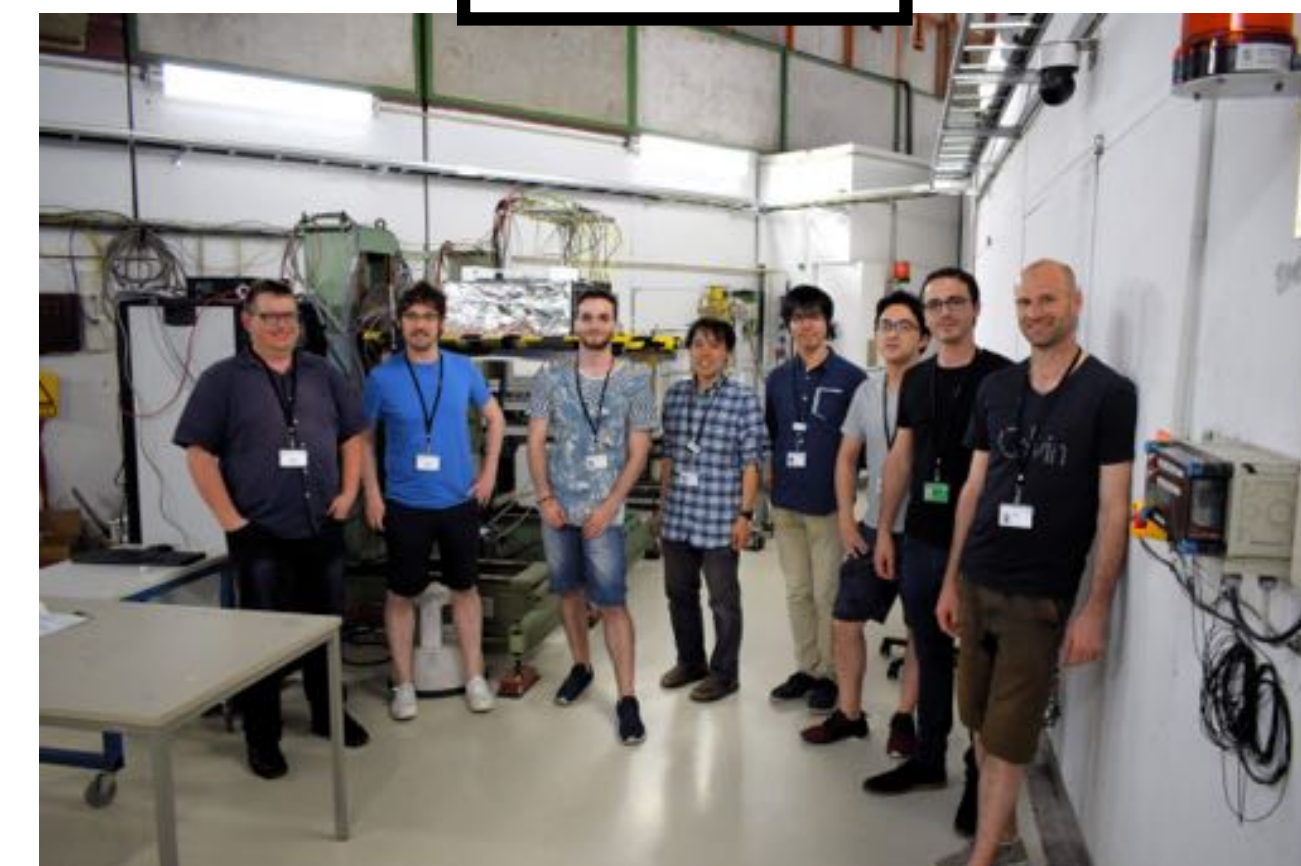
- using the following parameters
 - injection frequency : 200 kHz
 - injection voltage : 2.8 mVpp (2 MIP)
 - trigger : 230
 - ASIC channel : 13 channel
- TDC to real time conversion parameter
 - 0.127 ns / TDC count (up)
 - 0.066 ns / TDC count (down)



Test Beam 2019 (1)

- Purpose :
 - Data acquisition with electron beam (MIP, Shower)
 - Operation test (TDC, Auto Gain, etc.)
- 25th June 2019 - 5th July 2019 (DESY)
- Beam Status : electron, 1 - 5 GeV
- Setup : 5 slabs (Kyushu) and 4 Chip-In-Board slabs (France)
 - MIP (**without tungsten**)
 - Shower (**with tungsten**)

Members



Chip In Board



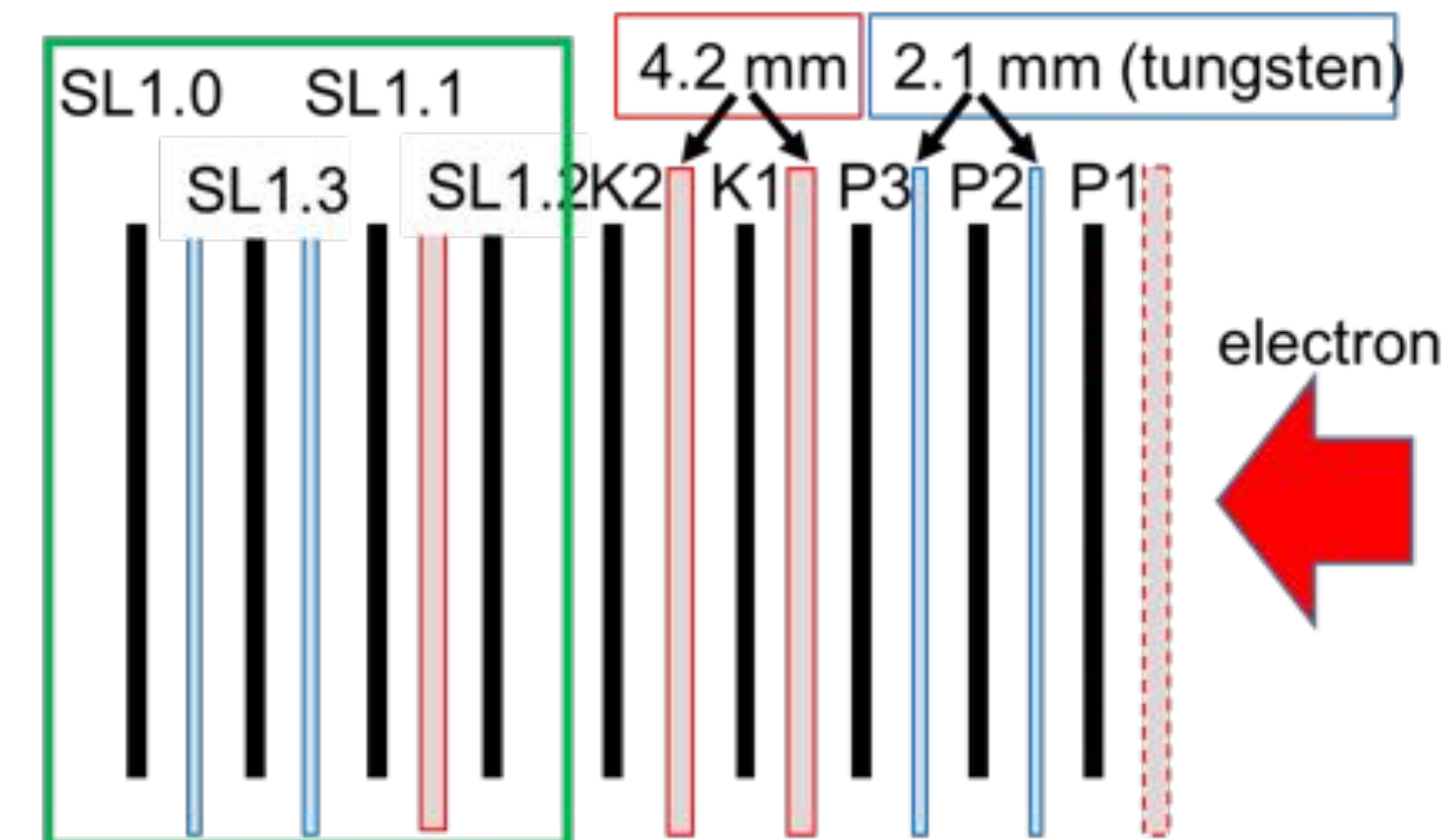
Test Beam 2019 (2)

box used in TB2019



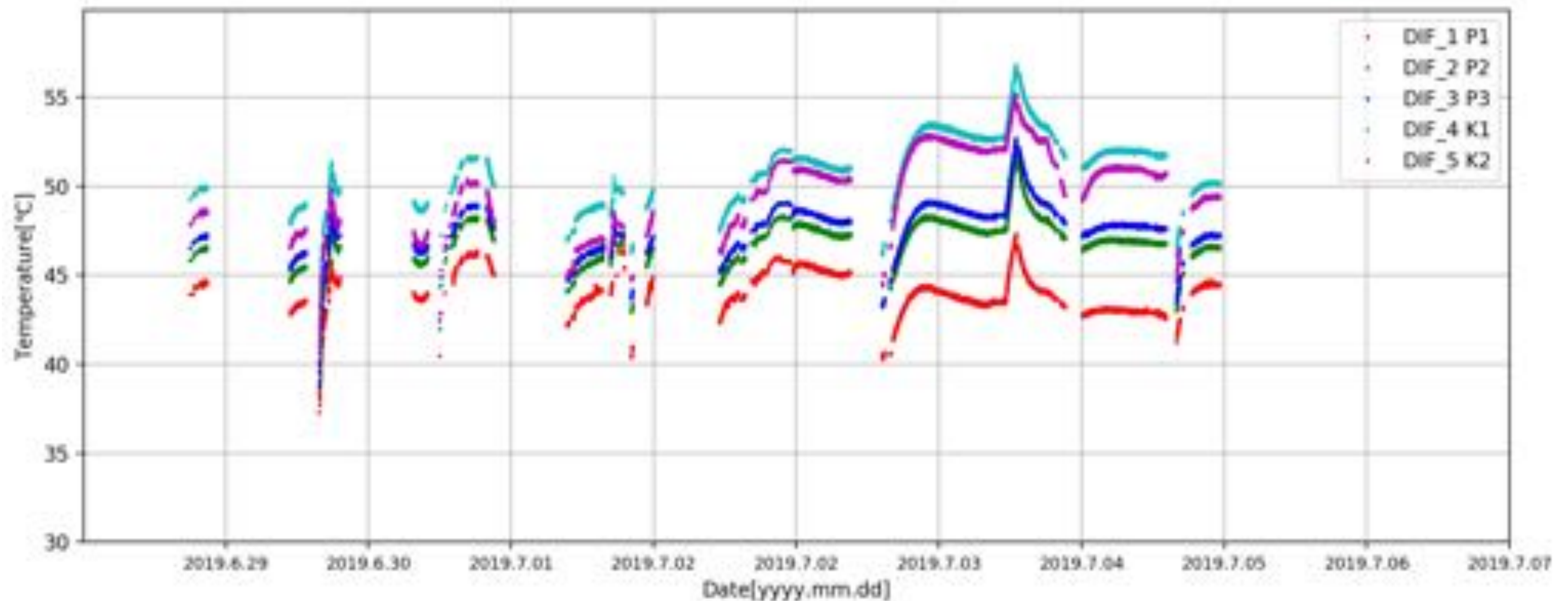
- The following box was used in TB2019
 - 5 slabs (Kyushu) were installed to this box
 - 4 CIB slabs (France group) were also installed
- The order of slabs is shown by the picture
- In shower setup,
We use two pattern thickness for tungsten
4.2 mm and 2.1 mm
- In detail explanation will be talked in analysis session

Shower setup



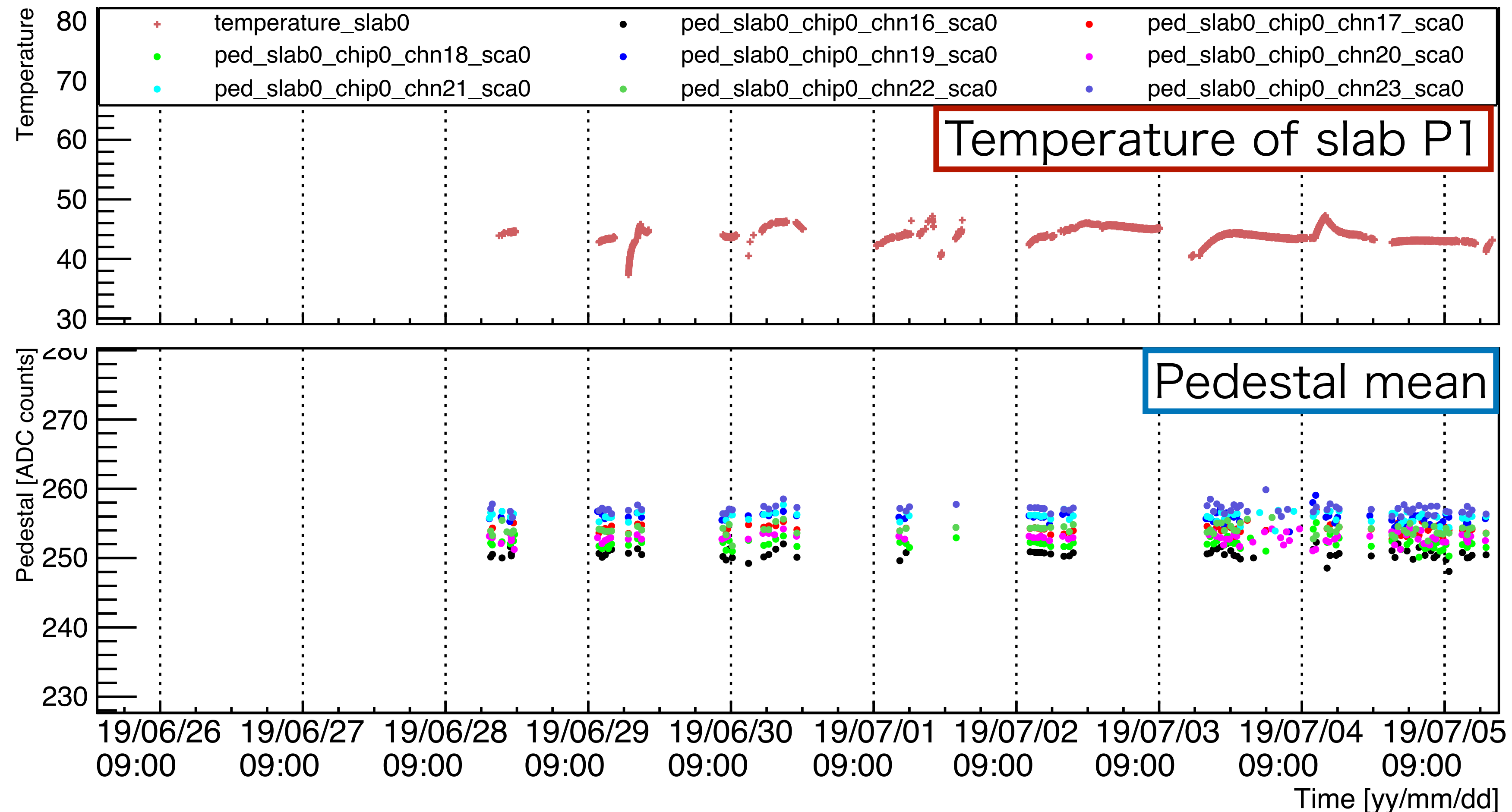
Temperature for all slabs

- Time variation of temperatures for all slabs



Temperature and Pedestal mean variation

- Time dependance of the temperature and pedestal mean



Some issues (1)

- Some issues were happened for connections
- HDMI connection
 - HDMI connections are unstable and loose
- HV connector
 - HV connectors are too fragile
- Complicated cable connection
 - Three cables per a slab must be connected to outside of the box

Complicated cable connection

outer

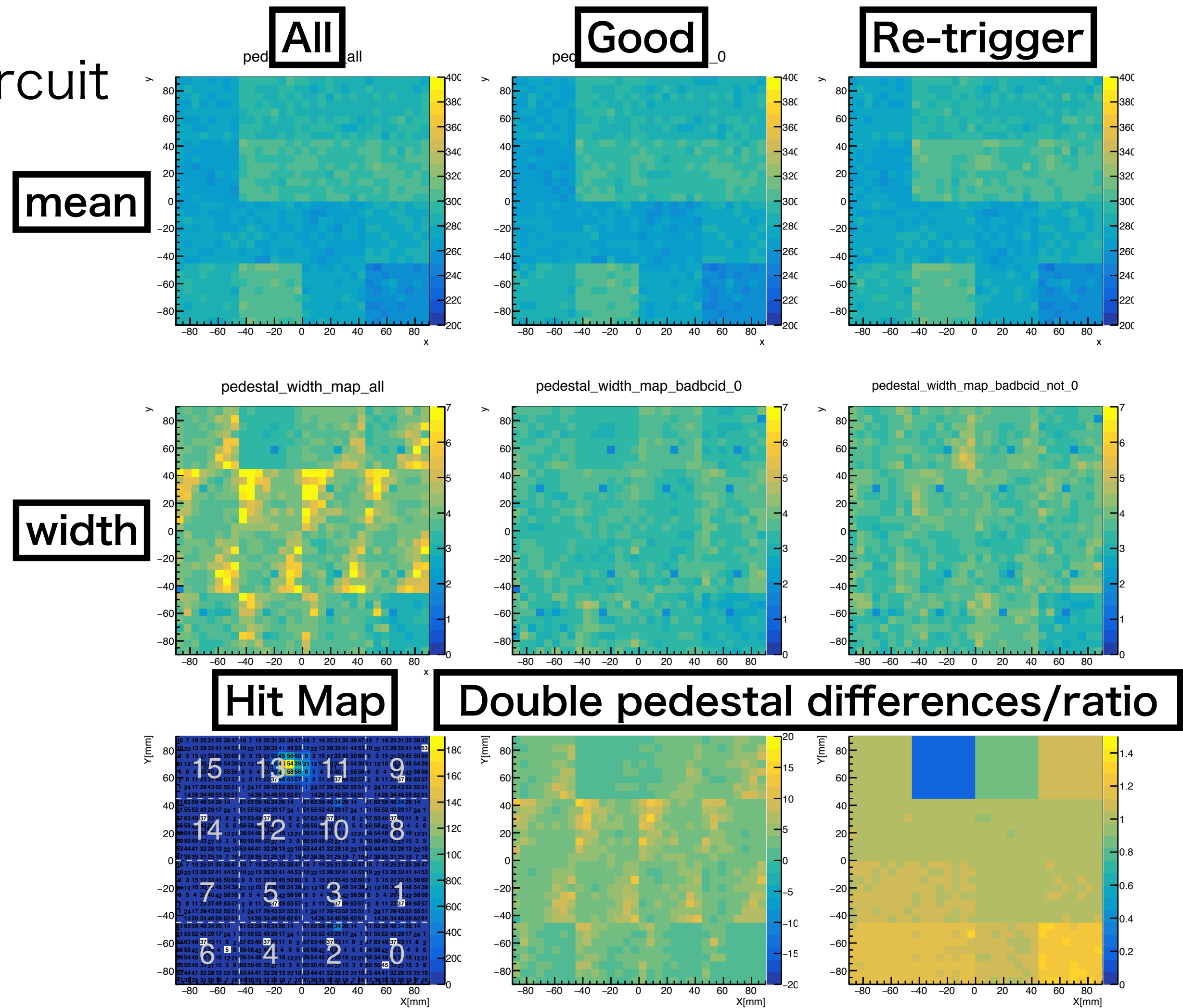
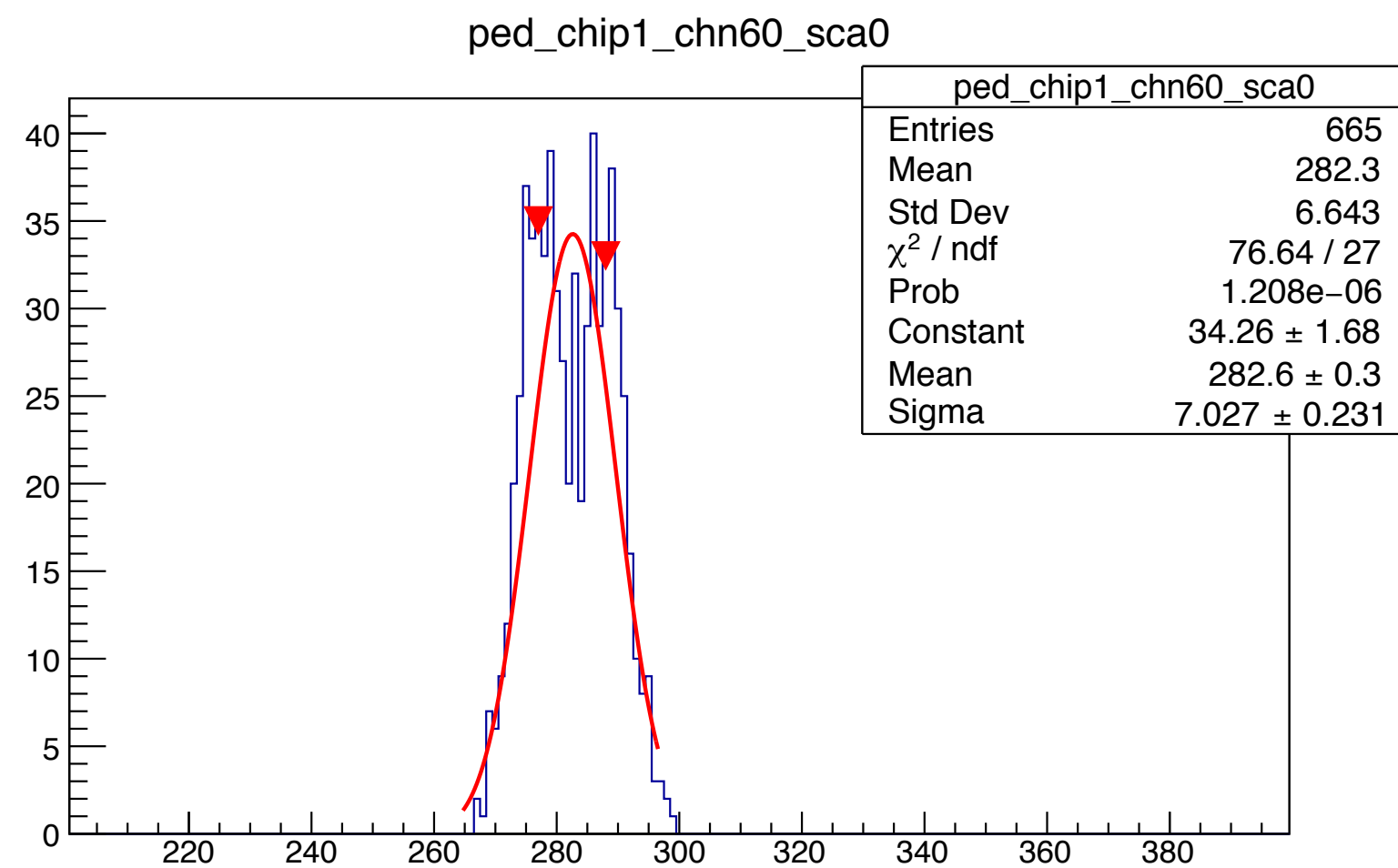


inner



Some issues (2)

- Some issues were found for reading circuit
- Re-triggering :
 - dummy hits after the hit
- Double pedestal
 - now studying



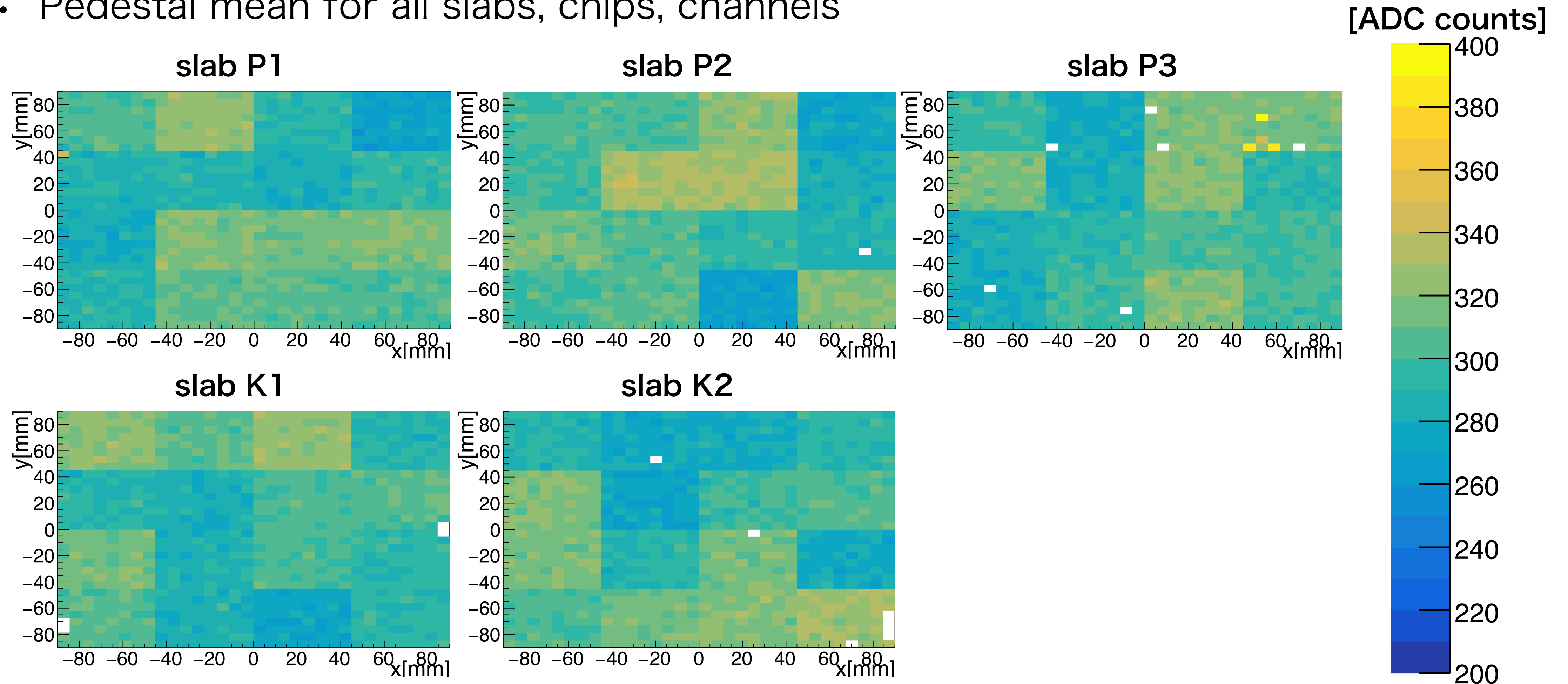
Summary and next plan

- Summary
 - Now, reading circuit for SiW-ECAL is optimized
 - We improved the slabs from the last Test Beam
 - We measured ADC data using gamma radiation sources
 - We calculated TDC convert parameter with charge injections
 - In detail analysis results are talked in the after talk
- Next plan
 - measurement of TDC for all channels

backup

Pedestal mean

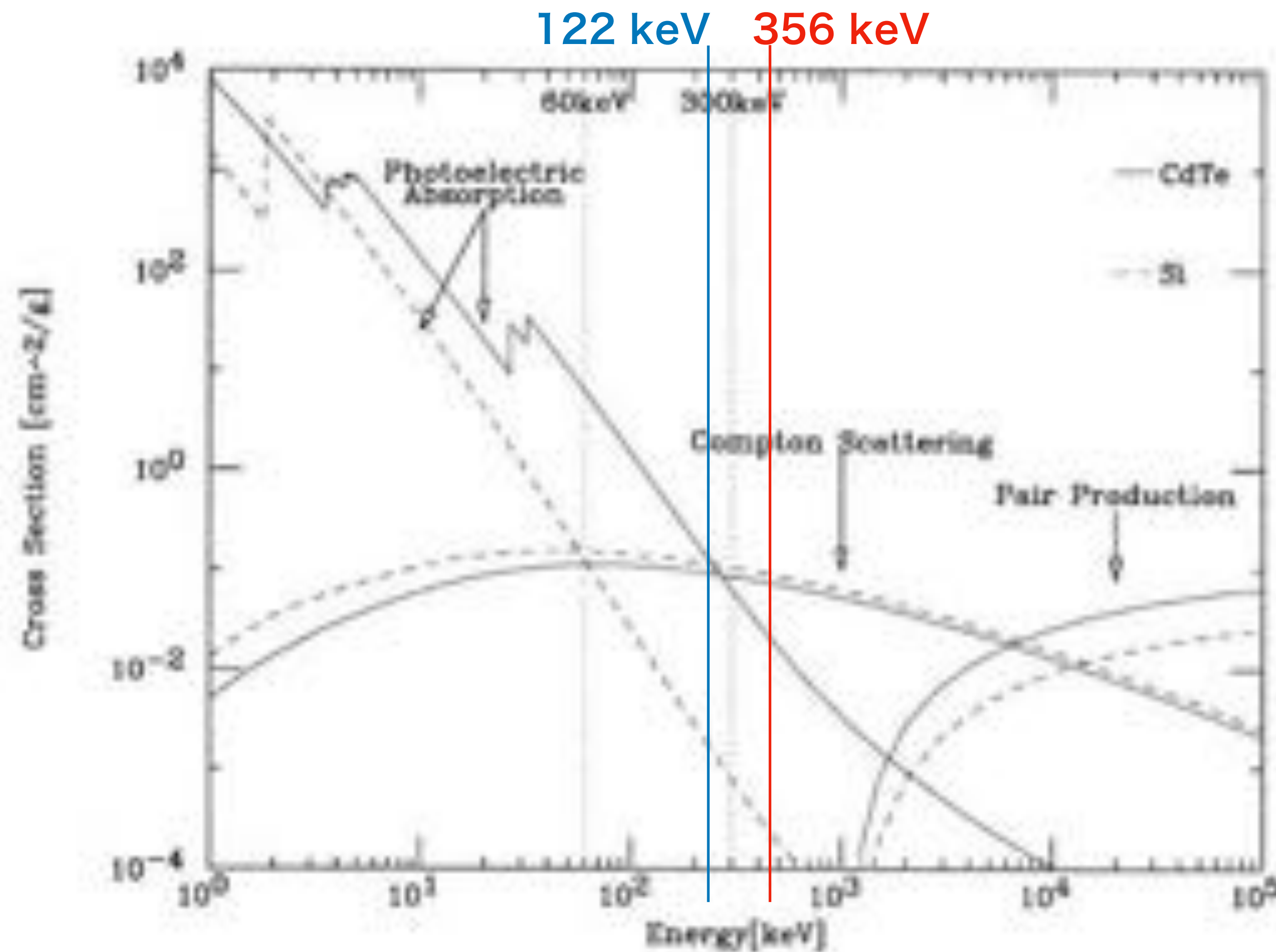
- Pedestal mean for all slabs, chips, channels



Measurement program

- MIP programs :
 - Position scan
 - Angle beam
 - TDC mode
 - Re-triggering / Double pedestal
- Shower programs :
 - TDC mode
 - Auto gain
 - Edge effect

Laboratory Test (2)

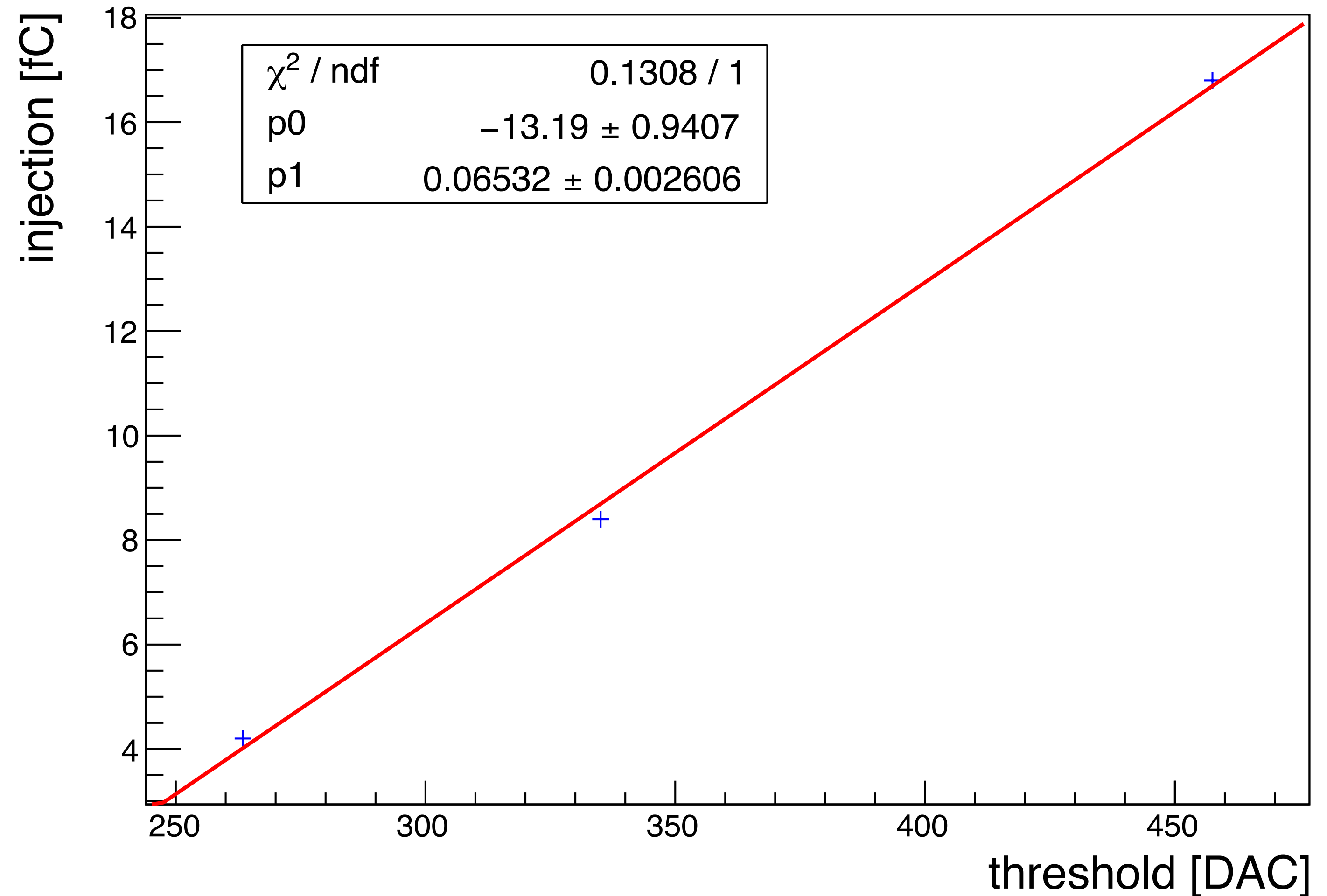


<引用>
修士論文「テルル化カドミウム (CdTe) 半導体を用いた硬X線・ガンマ線撮像用ビクセル検出器の開発」
東京大学大学院理学系研究科物理学専攻
宇宙科学研究所高橋研究室
渡辺博
2001年1月

Laboratory Test (3)

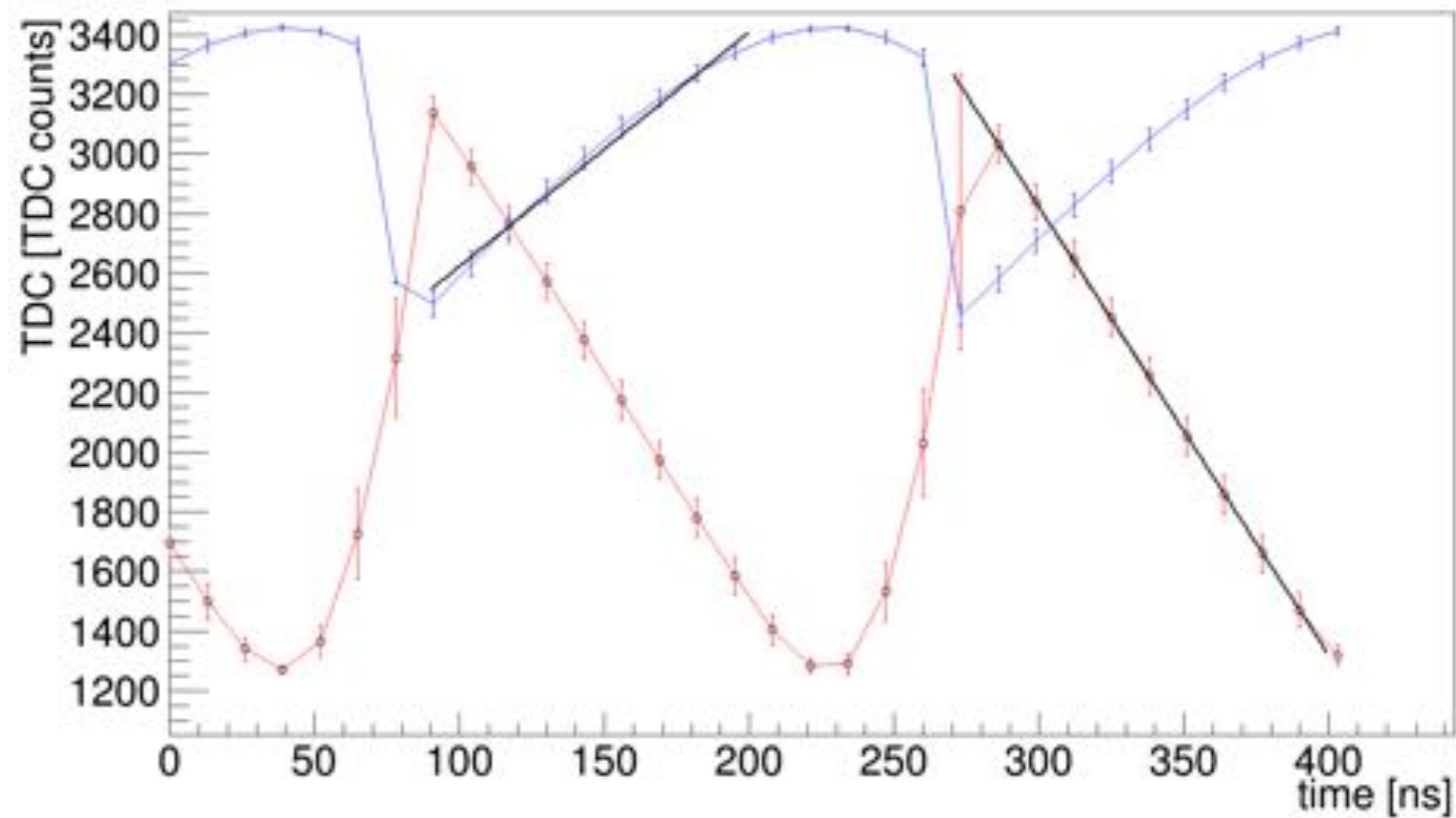
slabP1 chip15 ch56

- Linearity of threshold

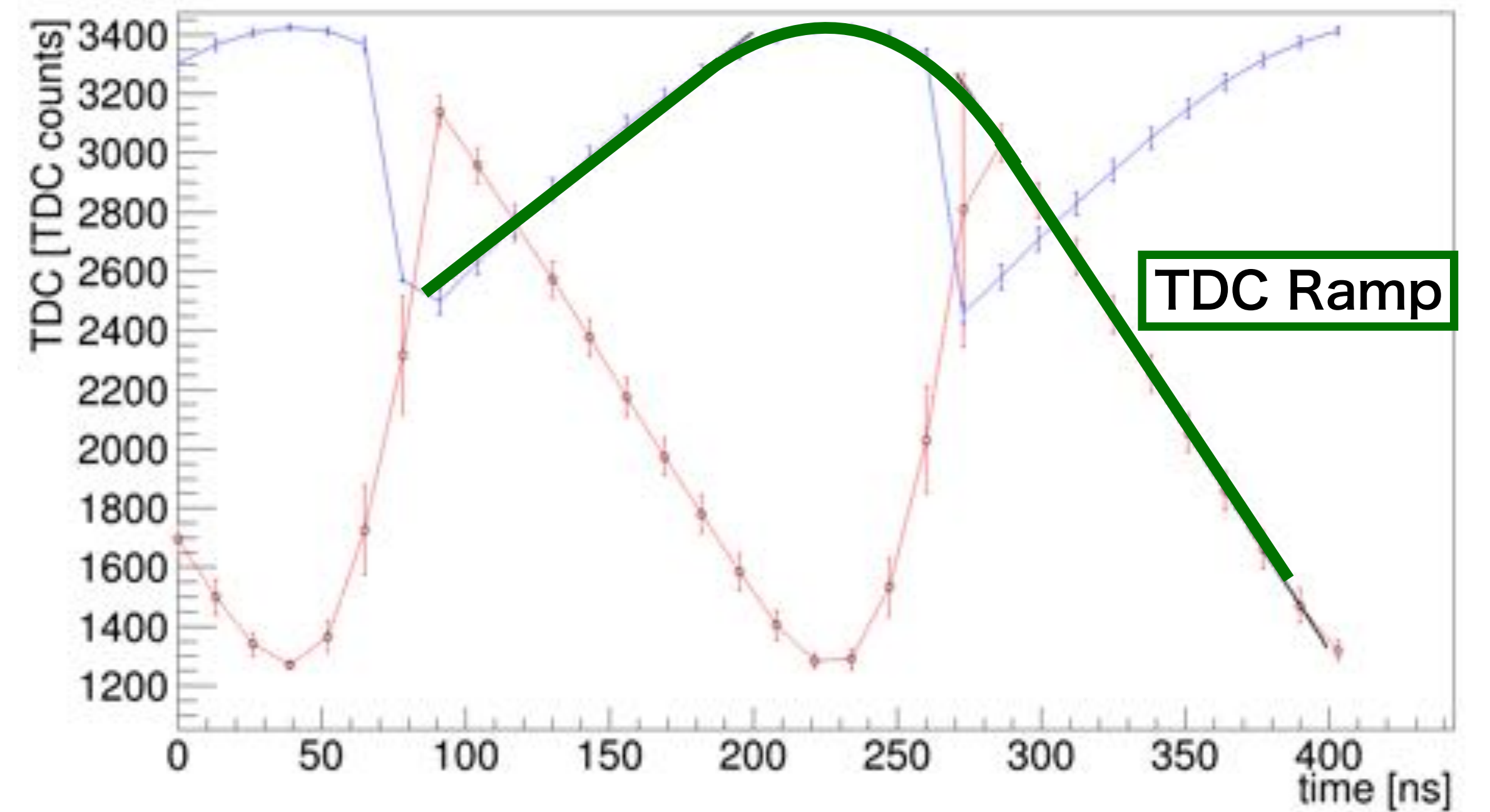


Laboratory Test (4)

TDC Ramp

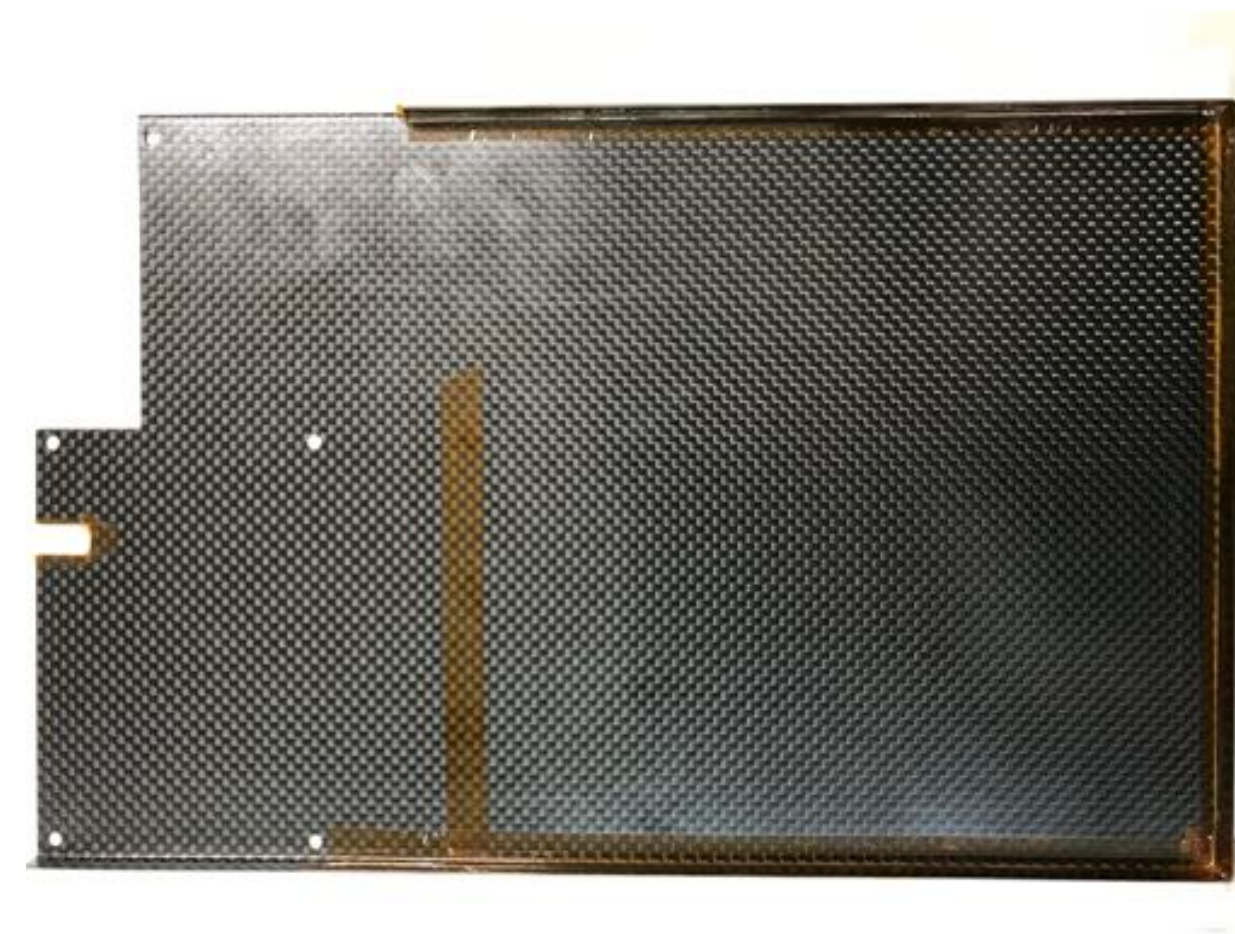
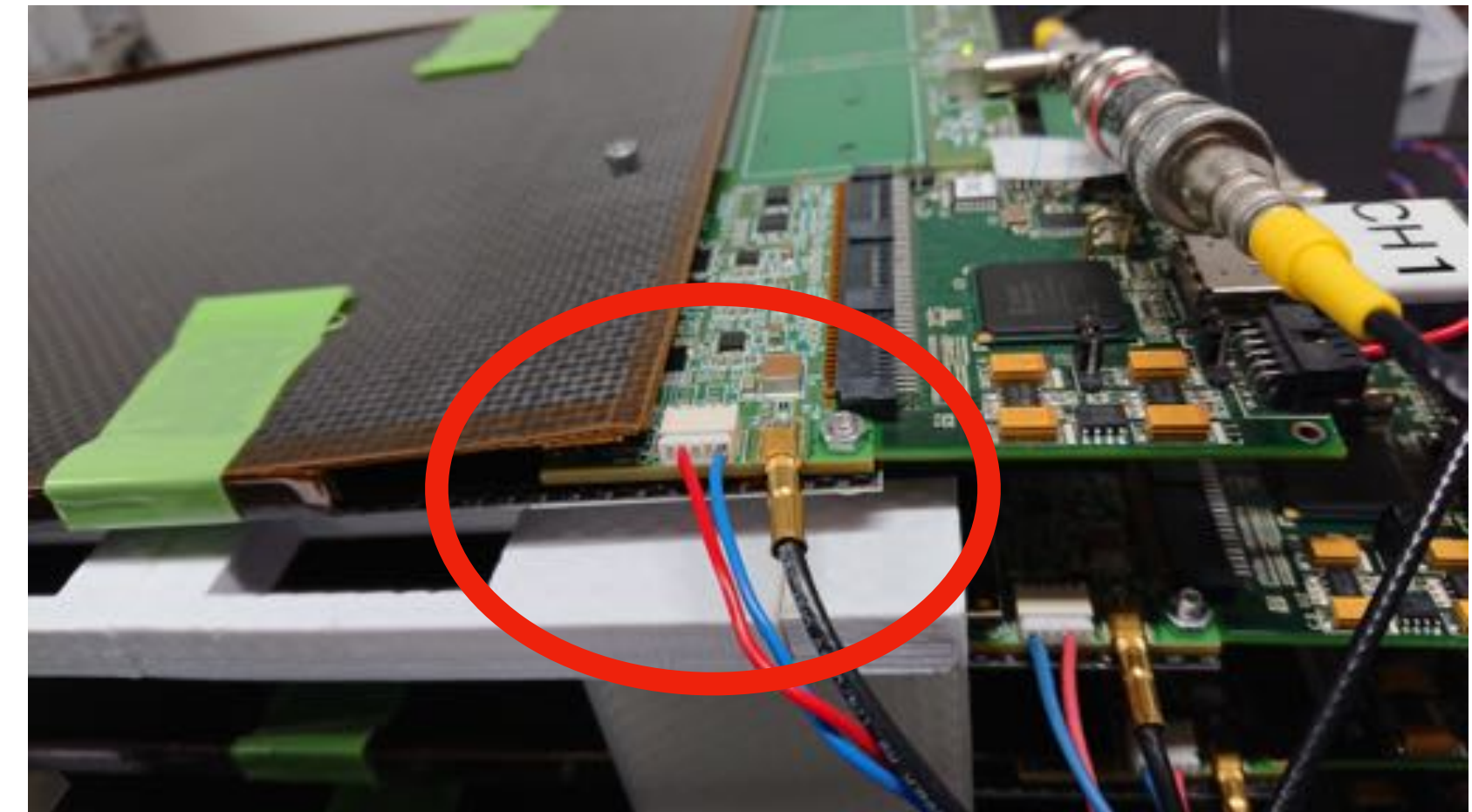


TDC Ramp

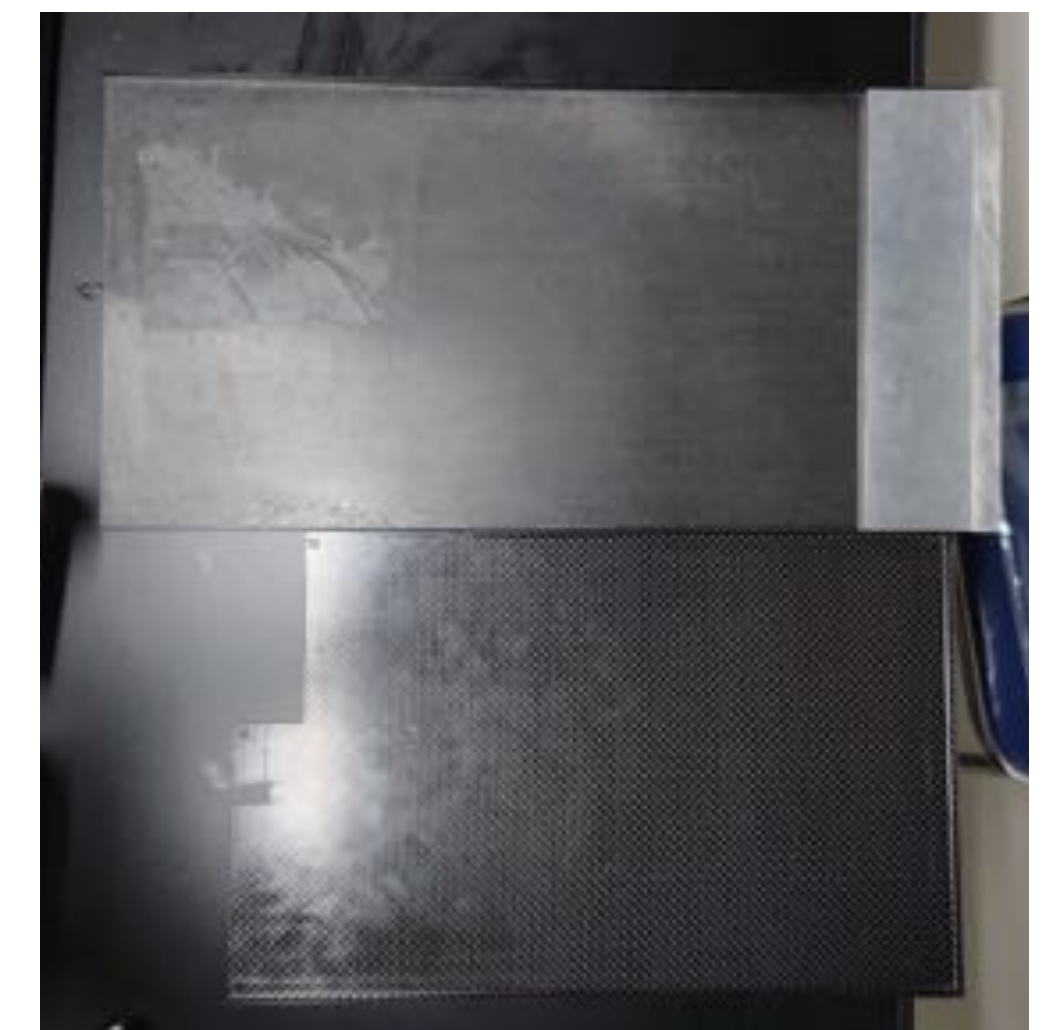


Update in this TB (1)

- Replace the carbon plate on the backside and cover
- New carbon plate :
 - cutting the edge of the HV connector side
 - pushing with screw
 - leakage current (imperfect insulation found)



Old



New